

บรรณานุกรม

- สุวัฒน์ ดั่น. 2538. เทคนิคและการออกแบบสวิตชิงเพาเวอร์ซัพพลาย. บริษัท เอนเทลไทย จำกัด
- ศิริชัย คล่องการพานิช. มิถุนายน 2539. เข้าใจไม่ยากกับการทำงานของสวิตชิงเรกูเลเตอร์. เซมิคอนดักเตอร์ อิเล็กทรอนิกส์ ฉบับที่ 160.
- วิสุทธิ์ อ้วนหนองศรี. 2535. วารสารคอมพิวเตอร์ อิเล็กทรอนิกส์เวิลด์ ฉบับที่ 137.
- ศิธีโรดม เกตุแก้ว. 2550. การศึกษาการออกแบบแหล่งจ่ายไฟฟ้ากระแสตรงแรงสูง สำหรับหลอดเอ็กซเรย์. การประชุมวิชาการวิทยาศาสตร์และเทคโนโลยีนิวเคลียร์ ครั้งที่ 10.
- Siseerot Ketkaew. 2007. The Case Study of 5 kHz-25 kHz High Frequency Adjustment in Converter Circuit to Generate Ozone Gas. AU Journal of Technology. Volume 11, Number 1.
- Siseerot Ketkaew and Krisada Bisuyabud. 2007. A Prototype For Dust Trap by Applied High Voltage DC Switching Power Supply. Proceedings of PCC Nagoya 2007, The Fourth Power Conversion Conference, Nagoya Congress Center, Nagoya, Japan.
- Siseerot Ketkaew. 2006. The Study and Construction of Ozone Air Cleaner By Electrostatic and Corona Discharge Application", Proceedings of The International Conference on Applied Science, Donechanh Palace, Vientiane, Lao PDR.
- Siseerot Ketkaew, 2006, A Study of Result Comparating of DC Source High Ripple Voltage Changing of Ozone Gas Quantity, The Joint Graduate School of Energy and Environment (JGSEE) King Mongkut's University of Technology Thonburi, 126 Pracha-Uthit Road, Bangmod, Tungkru, Bangkok 10140, Thailand.
- Siseerot Ketkaew, January 10-12, 2006, "A Design and Development of DC Switching Power Supply 5 Volt 240 Amp for Electrode Plates in The Waste Water Treatment Apparatus", Proceedings of International Conference Hazardous Waste Management for a Sustainable Future, National Research Center for Environmental and Hazardous Waste Management, Bangkok, Thailand

ภาคผนวก

ภาคผนวก ก
ดาต้าชีตไอซีเบอร์ TLP250

TOSHIBA Photocoupler GaAIAs Ired & Photo-IC

TLP250

Transistor Inverter
Inverter For Air Conditionor
IGBT Gate Drive
Power MOS FET Gate Drive

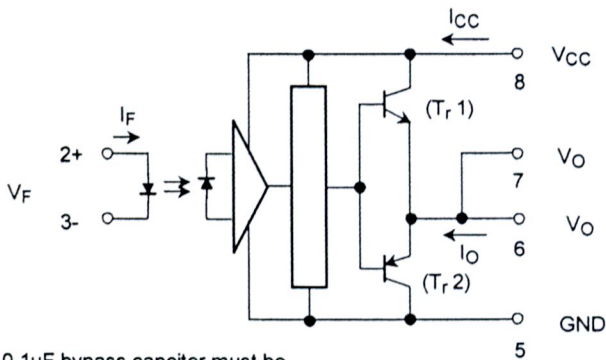
The TOSHIBA TLP250 consists of a GaAIAs light emitting diode and a integrated photodetector.
This unit is 8-lead DIP package.
TLP250 is suitable for gate driving circuit of IGBT or power MOS FET.

- Input threshold current: $I_F=5\text{mA}(\text{max.})$
- Supply current (I_{CC}): $11\text{mA}(\text{max.})$
- Supply voltage (V_{CC}): $10\text{--}35\text{V}$
- Output current (I_O): $\pm 1.5\text{A}(\text{max.})$
- Switching time (t_{pLH}/t_{pHL}): $1.5\mu\text{s}(\text{max.})$
- Isolation voltage: $2500V_{\text{rms}}(\text{min.})$
- UL recognized: UL1577, file No.E67349
- Option (D4) type
 - VDE approved: DIN VDE0884/06.92,certificate No.76823
 - Maximum operating insulation voltage: $630V_{\text{PK}}$
 - Highest permissible over voltage: $4000V_{\text{PK}}$

(Note) When a VDE0884 approved type is needed,
please designate the "option (D4)"

- Creepage distance: $6.4\text{mm}(\text{min.})$
- Clearance: $6.4\text{mm}(\text{min.})$

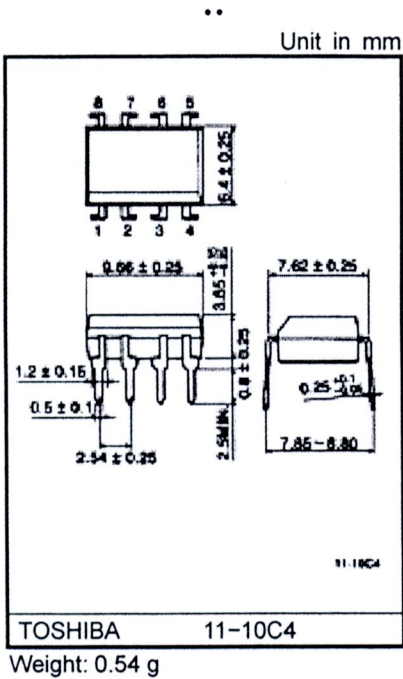
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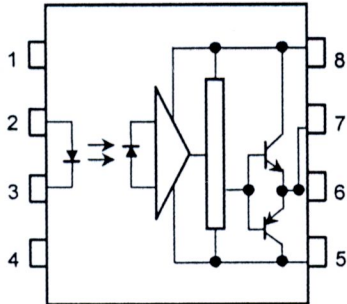
A $0.1\mu\text{F}$ bypass capcitor must be connected between pin 8 and 5 (See Note 5).

Truth Table

		Tr1	Tr2
Input LED	On	On	Off
	Off	Off	On



Pin Configuration (top view)



- 1 : N.C.
- 2 : Anode
- 3 : Cathode
- 4 : N.C.
- 5 : GND
- 6 : V_O (Output)
- 7 : V_O
- 8 : V_{CC}

Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit
LED	Forward current		I _F	20	mA
	Forward current derating (Ta ≥ 70°C)		ΔI _F / ΔTa	−0.36	mA / °C
	Peak transient forward curent (Note 1)		I _{FPT}	1	A
	Reverse voltage		V _R	5	V
	Junction temperature		T _j	125	°C
Detector	"H"peak output current (P _W ≤ 2.5μs, f ≤ 15kHz) (Note 2)		I _{OPH}	−1.5	A
	"L"peak output current (P _W ≤ 2.5μs, f ≤ 15kHz) (Note 2)		I _{OPL}	+1.5	A
	Output voltage	(Ta ≤ 70°C)	V _O	35	V
		(Ta = 85°C)		24	
	Supply voltage	(Ta ≤ 70°C)	V _{CC}	35	V
		(Ta = 85°C)		24	
	Output voltage derating (Ta ≥ 70°C)		ΔV _O / ΔTa	−0.73	V / °C
	Supply voltage derating (Ta ≥ 70°C)		ΔV _{CC} / ΔTa	−0.73	V / °C
	Junction temperature		T _j	125	°C
Operating frequency (Note 3)			f	25	kHz
Operating temperature range			T _{opr}	−20~85	°C
Storage temperature range			T _{stg}	−55~125	°C
Lead soldering temperature (10 s) (Note 4)			T _{sol}	260	°C
Isolation voltage (AC, 1 min., R.H.≤ 60%) (Note 5)			BV _S	2500	Vrms

- Note 1: Pulse width PW ≤ 1μs, 300pps
- Note 2: Exporential wavefom
- Note 3: Exporential wavefom, IOPH ≤ −1.0A(≤ 2.5μs), ILOPL ≤ +1.0A(≤ 2.5μs)
- Note 4: It is 2 mm or more from a lead root.
- Note 5: Device considered a two terminal device: Pins 1, 2, 3 and 4 shorted together, and pins 5, 6, 7 and 8 shorted together.
- Note 6: A ceramic capacitor(0.1μF) should be connected from pin 8 to pin 5 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching proparty. The total lead length between capacitor and coupler should not exceed 1cm.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Typ.	Max.		Unit
Input current, on (Note 7)	IF(ON)	7	8	10		mA
Input voltage, off	VF(OFF)	0	—	0.8		V
Supply voltage	VCC	15	—	30	20	V
Peak output current	IOPH/ILOPL	—	—	±0.5		A
Operating temperature	Topr	−20	25	70	85	°C

Note 7: Input signal rise time (fall time) < 0.5 μs.

Electrical Characteristics (Ta = -20~70°C, unless otherwise specified)

Characteristic		Symbol	Test Cir-cuit	Test Condition		Min.	Typ.*	Max.	Unit
Input forward voltage		V _F	—	I _F = 10 mA , Ta = 25°C			1.6	1.8	V
Temperature coefficient of forward voltage		ΔV _F / ΔTa	—	I _F = 10 mA		—	-2.0	—	mV / °C
Input reverse current		I _R	—	V _R = 5V, Ta = 25°C			—	10	μA
Input capacitance		C _T	—	V = 0 , f = 1MHz , Ta = 25°C		—	45	250	pF
Output current	"H" level	I _{OPH}	3	V _{CC} = 30V (*1)	I _F = 10 mA V ₈₋₆ = 4V	-0.5	-1.5	—	A
	"L" level	I _{OPL}	2		I _F = 0 V ₆₋₅ = 2.5V	0.5	2	—	
Output voltage	"H" level	V _{OH}	4	V _{CC1} = +15V, V _{EE1} = -15V R _L = 200Ω, I _F = 5mA		11	12.8	—	V
	"L" level	V _{OL}	5	V _{CC1} = +15V, V _{EE1} = -15V R _L = 200Ω, V _F = 0.8V		—	-14.2	-12.5	
Supply current	"H" level	I _{CCH}	—	V _{CC} = 30V, I _F = 10mA Ta = 25°C		—	7	—	mA
				V _{CC} = 30V, I _F = 10mA		—	—	11	
	"L" level	I _{CCL}	—	V _{CC} = 30V, I _F = 0mA Ta = 25°C		—	7.5	—	
				V _{CC} = 30V, I _F = 0mA		—	—	11	
Threshold input current	"Output L→H"	I _{FLH}	—	V _{CC1} = +15V, V _{EE1} = -15V R _L = 200Ω, V _O > 0V		—	1.2	5	mA
Threshold input voltage	"Output H→L"	I _{FHL}	—	V _{CC1} = +15V, V _{EE1} = -15V R _L = 200Ω, V _O < 0V		0.8	—	—	V
Supply voltage		V _{CC}	—			10	—	35	V
Capacitance (input-output)		C _S	—	V _S = 0 , f = 1MHz Ta = 25° •		—	1.0	2.0	pF
Resistance(input-output)		R _S	—	V _S = 500V , Ta = 25°C R.H.≤ 60%		1×10 ¹²	10 ¹⁴	—	Ω

* All typical values are at Ta = 25°C (*1): Duration of I_O time ≤ 50μs

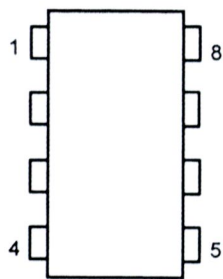
Switching Characteristics (Ta = -20~70°C , unless otherwise specified)

Characteristic		Symbol	Test Cir-cuit	Test Condition	Min.	Typ.*	Max.	Unit
Propagation delay time	L→H	t _{pLH}	6	I _F = 8mA (Note 7) V _{CC1} = +15V, V _{EE1} = -15V R _L = 200Ω	—	0.15	0.5	μs
	H→L	t _{pHL}			—	0.15	0.5	
Output rise time		t _r			—	—	—	
Output fall time		t _f			—	—	—	
Common mode transient immunity at high level output		C _{MH}	7	V _{CM} = 600V, I _F = 8mA V _{CC} = 30V, Ta = 25°C	-5000	—	—	V / μs
Common mode transient immunity at low level output		C _{ML}	7	V _{CM} = 600V, I _F = 0mA V _{CC} = 30V, Ta = 25°C	5000	—	—	V / μs

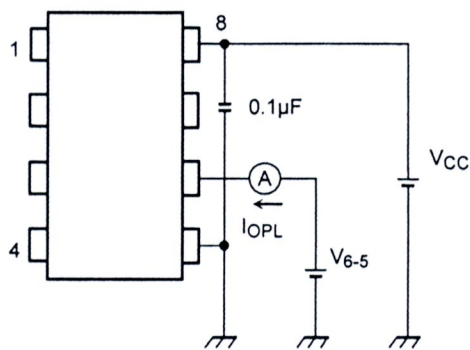
* All typical values are at Ta = 25°C

Note 7: Input signal rise time (fall time) < 0.5 μs.

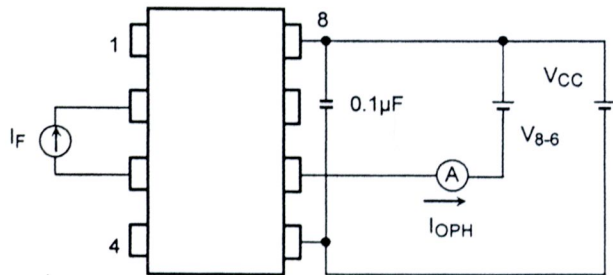
Test Circuit 1 :



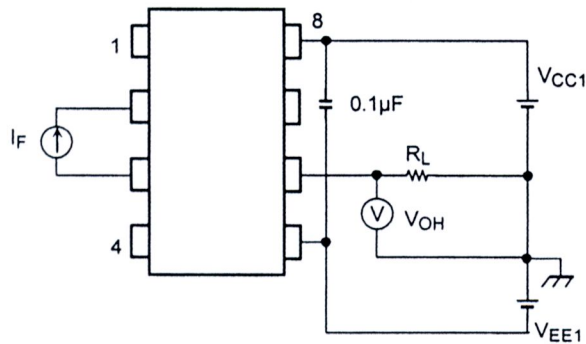
Test Circuit 2 : IOPL



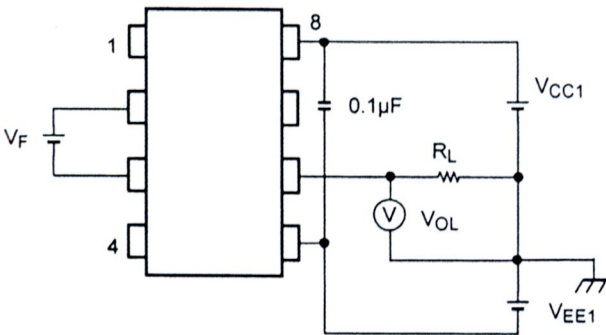
Test Circuit 3 : IOPH



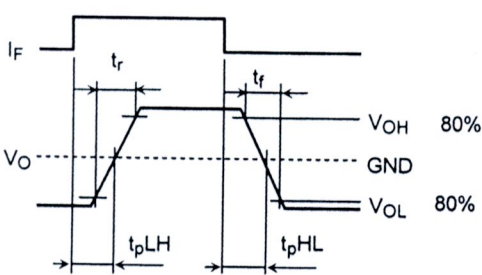
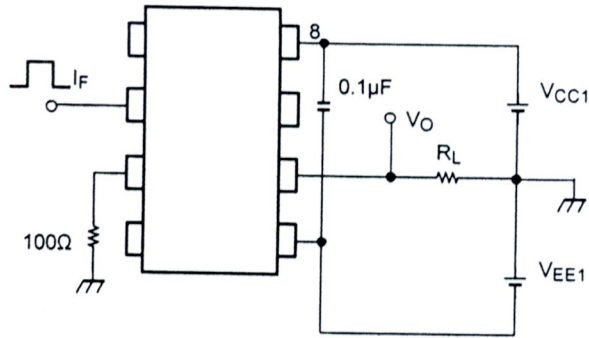
Test Circuit 4 : VOH



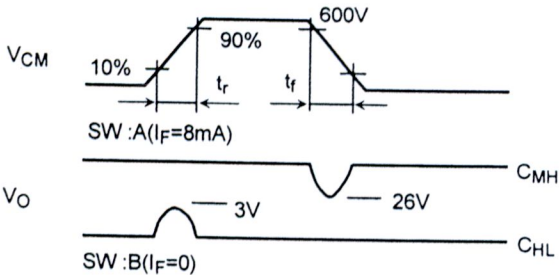
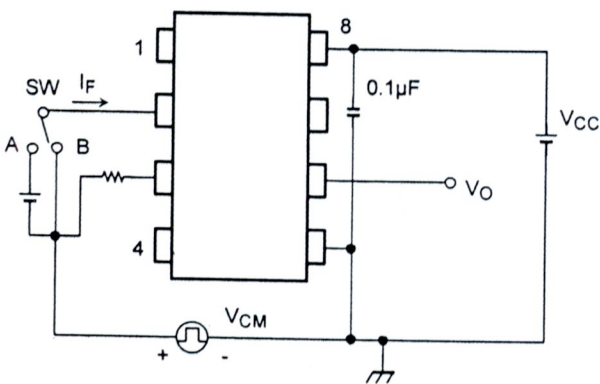
Test Circuit 5 : VOL



Test Circuit 6: t_{pLH} , t_{pHL} , t_r , t_f



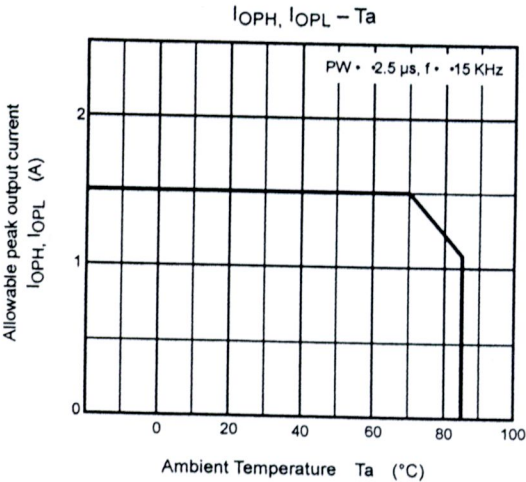
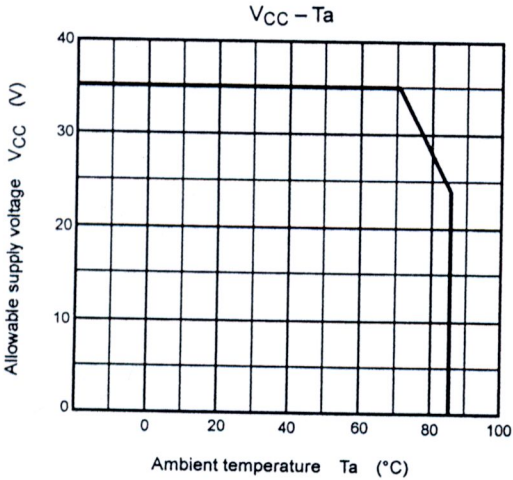
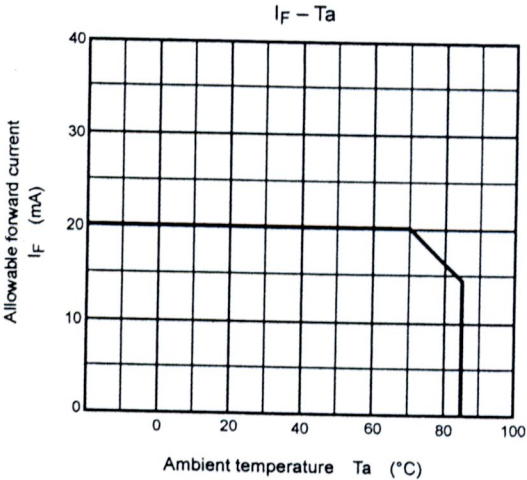
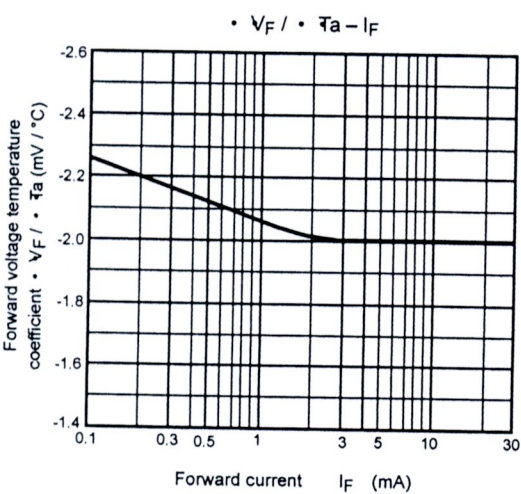
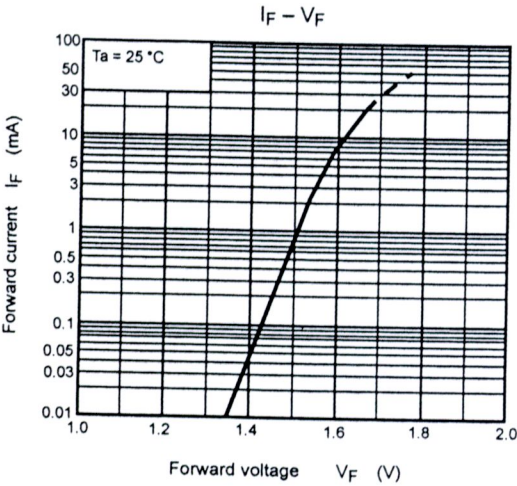
Test Circuit 7: C_{MH} , C_{ML}



$$C_{ML} = \frac{480 \text{ (V)}}{t_r \text{ (}\mu\text{s)}}$$

$$C_{MH} = \frac{480 \text{ (V)}}{t_f \text{ (}\mu\text{s)}}$$

$C_{ML}(C_{MH})$ is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the low (high) state.



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- GaAs(Gallium Arsenide) is used in this product. The dust or vapor is harmful to the human body. Do not break, cut, crush or dissolve chemically.

ภาคผนวก ข
ดัด้าชีวิตเพาเวอร์มอสเฟต เบอร์ IRFP460

**20A, 500V, 0.270 Ohm, N-Channel
Power MOSFET**

This N-Channel enhancement mode silicon gate power field effect transistor is an advanced power MOSFET designed, tested, and guaranteed to withstand a specified level of energy in the breakdown avalanche mode of operation. All of these power MOSFETs are designed for applications such as switching regulators, switching convertors, motor drivers, relay drivers, and drivers for high power bipolar switching transistors requiring high speed and low gate drive power. These types can be operated directly from integrated circuits.

Formerly developmental type TA17465.

Ordering Information

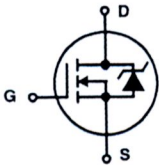
PART NUMBER	PACKAGE	BRAND
IRFP460	TO-247	IRFP460

NOTE: When ordering, use the entire part number.

Features

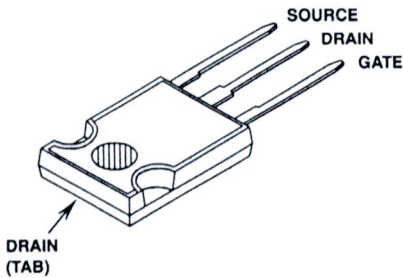
- 20A, 500V
- $r_{DS(ON)} = 0.270\Omega$
- Single Pulse Avalanche Energy Rated
- SOA is Power Dissipation Limited
- Nanosecond Switching Speeds
- Linear Transfer Characteristics
- High Input Impedance
- Related Literature
 - TB334 "Guidelines for Soldering Surface Mount Components to PC Boards"

Symbol



Packaging

JEDEC STYLE TO-247



IRFP460

Absolute Maximum Ratings $T_C = 25^{\circ}\text{C}$, Unless Otherwise Specified

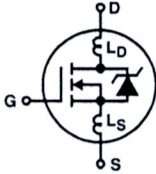
	IRFP460	UNITS
Drain to Source Voltage (Note 1)	V_{DS} 500	V
Drain to Gate Voltage ($R_{GS} = 20\text{k}\Omega$) (Note 1)	V_{DGR} 500	V
Continuous Drain Current	I_D 20	A
$T_C = 100^{\circ}\text{C}$	I_D 12	A
Pulsed Drain Current (Note 3)	I_{DM} 80	A
Gate to Source Voltage	V_{GS} ± 20	V
Maximum Power Dissipation	P_D 250	W
Linear Derating Factor	2.0	$\text{W}/^{\circ}\text{C}$
Single Pulse Avalanche Energy Rating (Note 4)	E_{AS} 960	mJ
Operating and Storage Temperature	T_J, T_{STG} -55 to 150	$^{\circ}\text{C}$
Maximum Temperature for Soldering		
Leads at 0.063in (1.6mm) from Case for 10s.	T_L 300	$^{\circ}\text{C}$
Package Body for 10s, See Techbrief 334	T_{pkg} 260	$^{\circ}\text{C}$

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. $T_J = 25^{\circ}\text{C}$ to $T_J = 125^{\circ}\text{C}$.

Electrical Specifications $T_C = 25^{\circ}\text{C}$, Unless Otherwise Specified

PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNITS
Drain to Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V (Figure 10)		500	-	-	V
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 250μA		2	-	4	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = Rated BV _{DSS} , V _{GS} = 0V		-	-	25	μA
		V _{DS} = 0.8 x Rated BV _{DSS} , V _{GS} = 0V, T _J = 125°C		-	-	250	μA
On-State Drain Current (Note 2)	I _{D(ON)}	V _{DS} > I _{D(ON)} × r _{DS(ON)MAX} , V _{GS} = 10V		20	-	-	A
Gate to Source Leakage Current	I _{GSS}	V _{GS} = ±20V		-	-	±100	nA
Drain to Source On Resistance (Note 2)	r _{DS(ON)}	I _D = 11A, V _{GS} = 10V (Figures 8, 9)		-	0.24	0.27	Ω
Forward Transconductance (Note 2)	g _{fs}	V _{DS} ≥ 50V, I _{DS} > 11A (Figure 12)		13	19	-	S
Turn-On Delay Time	t _{d(ON)}	V _{DD} = 250V, I _D = 21A, R _{GS} = 4.3Ω, R _D = 12Ω, V _{GS} = 10V MOSFET Switching Times are Essentially Independent of Operating Temperature	-	23	35	ns	
Rise Time	t _r		-	81	120	ns	
Turn-Off Delay Time	t _{d(OFF)}		-	85	130	ns	
Fall Time	t _f		-	65	98	ns	
Total Gate Charge (Gate to Source + Gate-Drain)	Q _{g(TOT)}	V _{GS} = 10V, I _D = 21A, V _{DS} = 0.8 x Rated BV _{DSS} , I _{G(REF)} = 1.5mA (Figure 14). Gate Charge is Essentially Independent of Operating Temperature		-	120	190	nC
Gate to Source Charge	Q _{gs}			-	18	-	nC
Gate to Drain "Miller" Charge	Q _{gd}			-	62	-	nC
Input Capacitance	C _{ISS}	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz (Figure 10)		-	4100	-	pF
Output Capacitance	C _{OSS}			-	480	-	pF
Reverse Transfer Capacitance	C _{RSS}			-	84	-	pF
Internal Drain Inductance	L _D	Measured from the Drain Lead, 6mm (0.25in) from Package to Center of Die	Modified MOSFET Symbol Showing the Internal Device Inductances 	-	5.0	-	nH
Internal Source Inductance	L _S	Measured from the Source Lead, 6mm (0.25in) from Header to Source Bonding Pad		-	13	-	nH
Thermal Resistance Junction to Case	R _{θJC}			-	-	0.50	°C/W
Thermal Resistance Junction to Ambient	R _{θJA}	Free Air Operation		-	-	30	°C/W

IRFP460

Source to Drain Diode Specifications

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Continuous Source to Drain Current	I_{SD}	Modified MOSFET Symbol Showing the Integral Reverse P-N Junction Rectifier	-	-	20	A
Pulse Source to Drain Current (Note 3)	I_{SDM}		-	-	80	A
Source to Drain Diode Voltage (Note 2)	V_{SD}	$T_J = 25^{\circ}\text{C}$, $I_{SD} = 21\text{A}$, $V_{GS} = 0\text{V}$ (Figure 13)	-	-	1.8	V
Reverse Recovery Time	t_{rr}	$T_J = 25^{\circ}\text{C}$, $I_{SD} = 21\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	280	580	1200	ns
Reverse Recovery Charge	Q_{RR}	$T_J = 25^{\circ}\text{C}$, $I_{SD} = 21\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	3.8	8.1	18	μC

NOTES:

- 2. Pulse test: pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- 3. Repetitive rating: pulse width limited by Max junction temperature. See Transient Thermal Impedance curve (Figure 3).
- 4. $V_{DD} = 50\text{V}$, starting $T_J = 25^{\circ}\text{C}$, $L = 4.3\text{mH}$, $R_{GS} = 25\Omega$, Peak $I_{AS} = 20\text{A}$.

Typical Performance Curves Unless Otherwise Specified

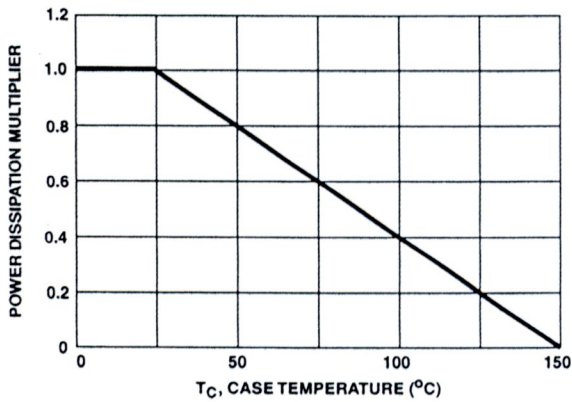


FIGURE 1. NORMALIZED POWER DISSIPATION vs CASE TEMPERATURE

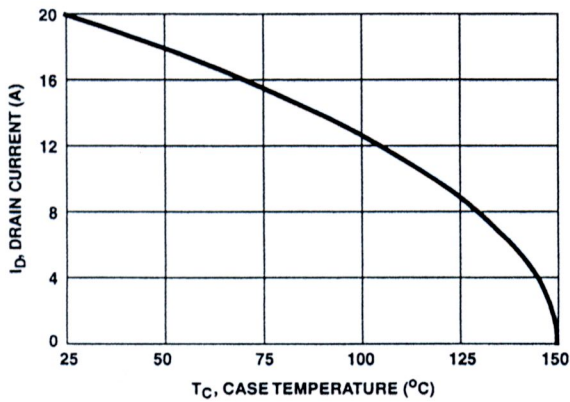


FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

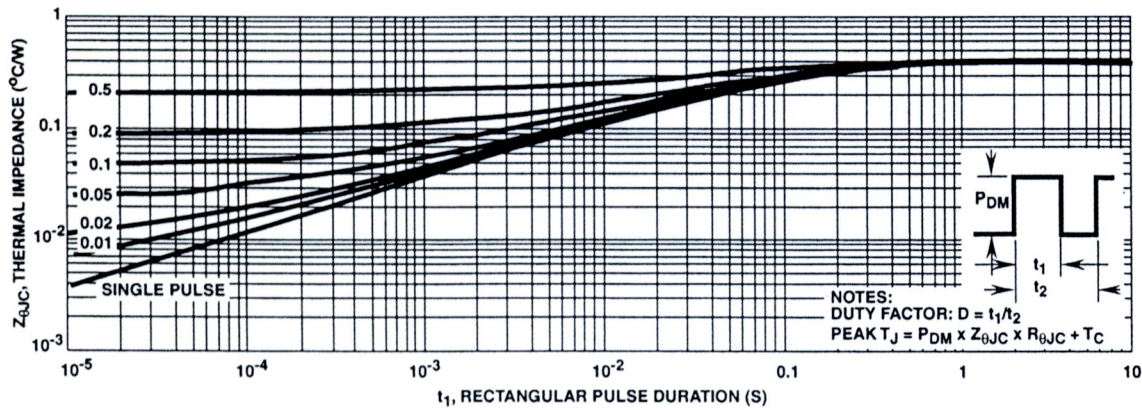


FIGURE 3. MAXIMUM TRANSIENT THERMAL IMPEDANCE

Typical Performance Curves Unless Otherwise Specified (Continued)

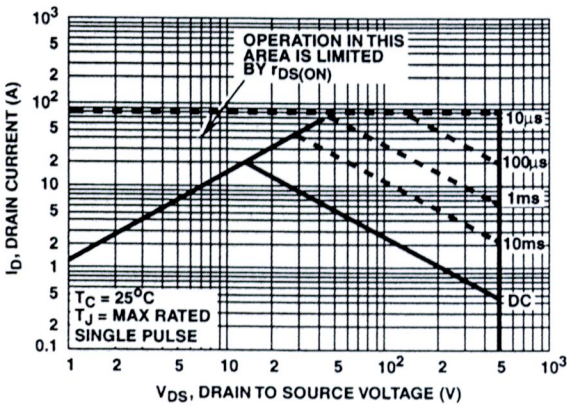


FIGURE 4. FORWARD BIAS SAFE OPERATING AREA

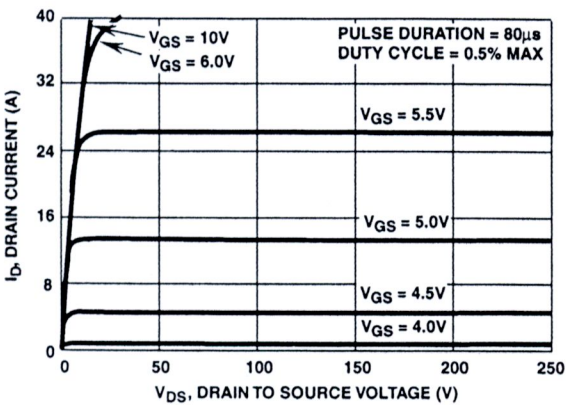


FIGURE 5. OUTPUT CHARACTERISTICS

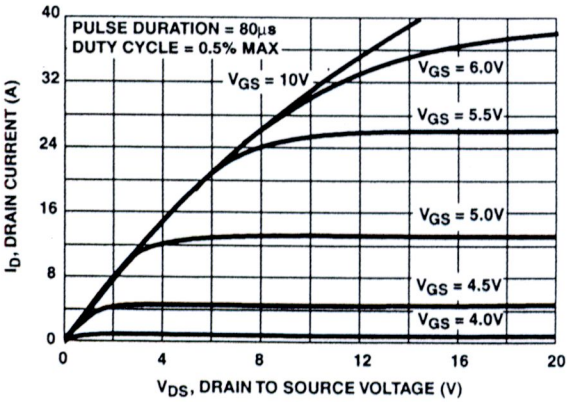


FIGURE 6. SATURATION CHARACTERISTICS

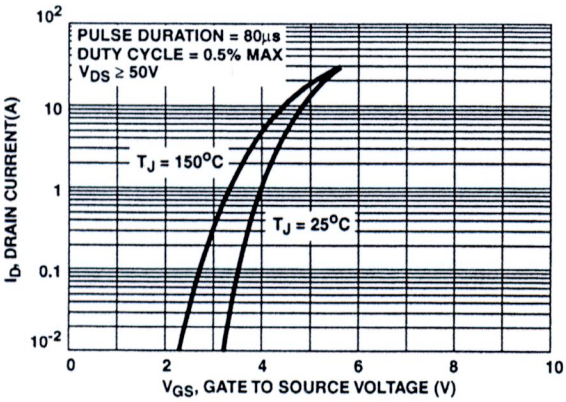


FIGURE 7. TRANSFER CHARACTERISTICS

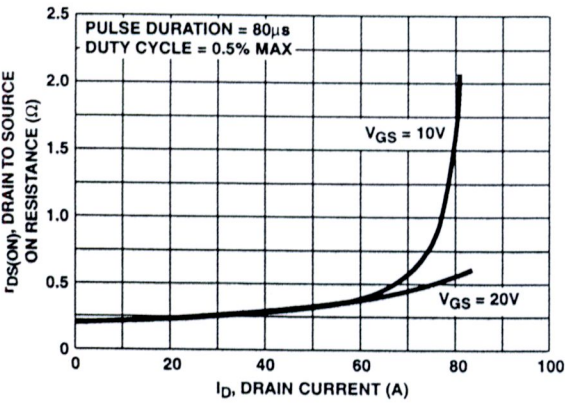


FIGURE 8. DRAIN TO SOURCE ON RESISTANCE vs GATE VOLTAGE AND DRAIN CURRENT

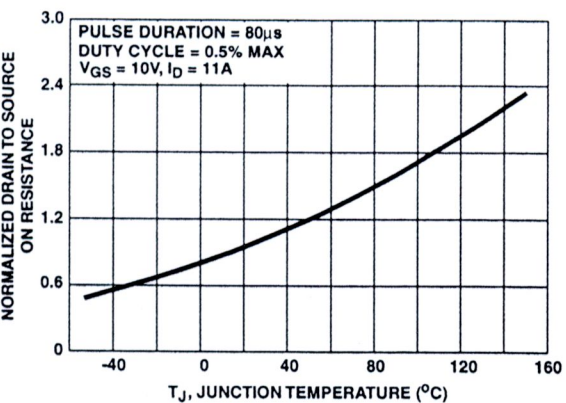


FIGURE 9. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs JUNCTION TEMPERATURE

Typical Performance Curves Unless Otherwise Specified (Continued)

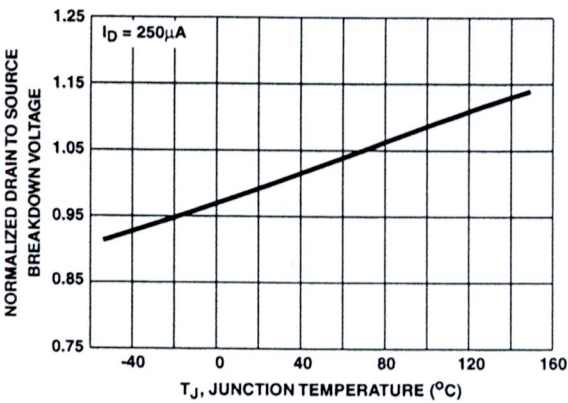


FIGURE 10. NORMALIZED DRAIN TO SOURCE BREAKDOWN VOLTAGE vs JUNCTION TEMPERATURE

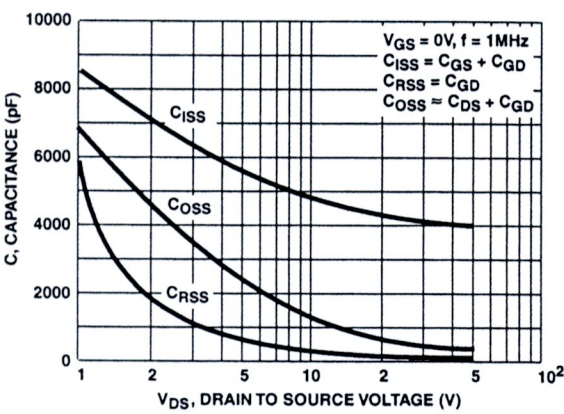


FIGURE 11. CAPACITANCE vs DRAIN TO SOURCE VOLTAGE

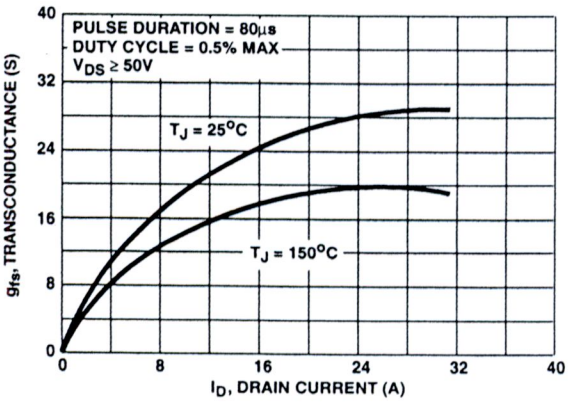


FIGURE 12. TRANSCONDUCTANCE vs DRAIN CURRENT

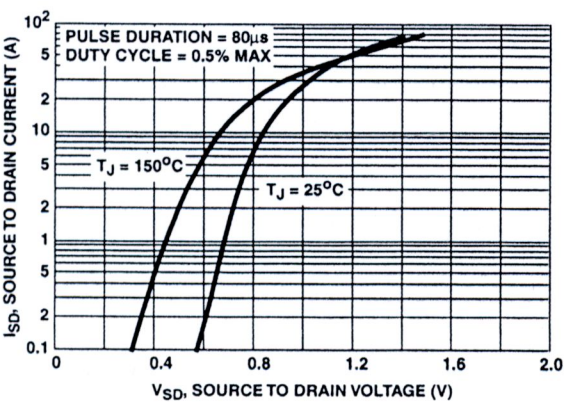


FIGURE 13. SOURCE TO DRAIN DIODE VOLTAGE

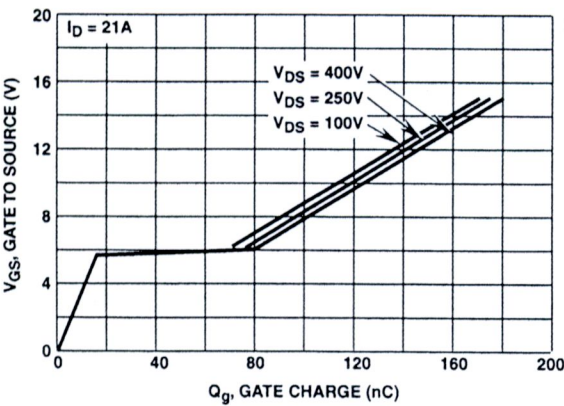


FIGURE 14. GATE TO SOURCE VOLTAGE vs GATE CHARGE



IRFP460

Test Circuits and Waveforms

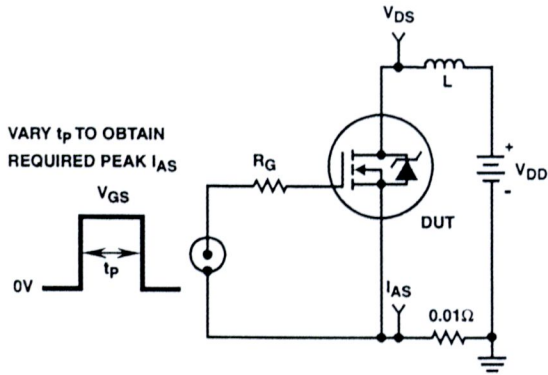


FIGURE 15. UNCLAMPED ENERGY TEST CIRCUIT

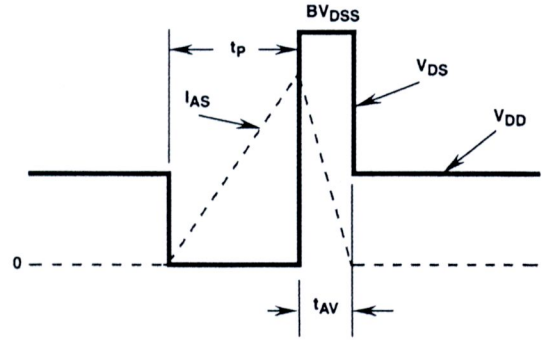


FIGURE 16. UNCLAMPED ENERGY WAVEFORMS

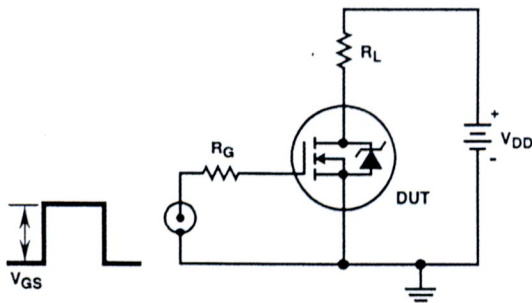


FIGURE 17. SWITCHING TIME TEST CIRCUIT

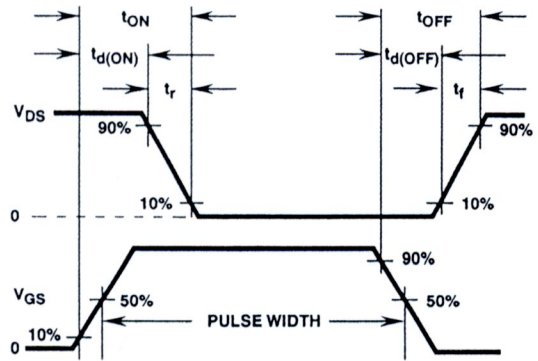


FIGURE 18. RESISTIVE SWITCHING WAVEFORMS

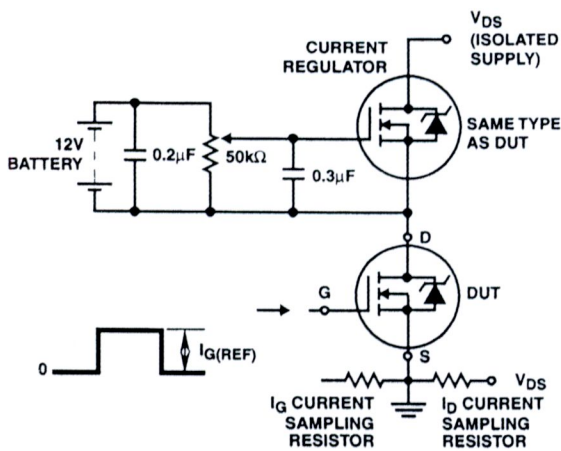


FIGURE 19. GATE CHARGE TEST CIRCUIT

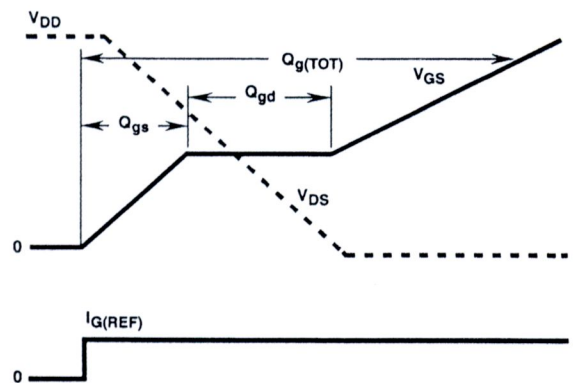


FIGURE 20. GATE CHARGE WAVEFORMS

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DOME™	ISOPLANAR™	QT Optoelectronics™	UHC™
EcoSPARK™	LittleFET™	Quiet Series™	UltraFET™
E²CMOS™	MicroFET™	SILENT SWITCHER®	VCX™
EnSigna™	MICROWIRE™	SMART START™	
FACT™	OPTOLOGIC™	Star* Power™	
FACT Quiet Series™	OPTOPLANAR™	Stealth™	

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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

ภาคผนวก ค
ดาต้าชีตไอซีเบอร์ TL494

TL494

SWITCHMODE™ Pulse Width Modulation Control Circuit

The TL494 is a fixed frequency, pulse width modulation control circuit designed primarily for SWITCHMODE power supply control.

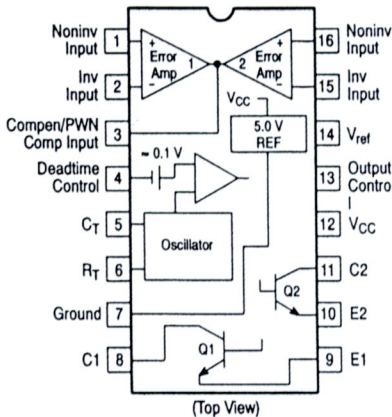
- Complete Pulse Width Modulation Control Circuitry
- On-Chip Oscillator with Master or Slave Operation
- On-Chip Error Amplifiers
- On-Chip 5.0 V Reference
- Adjustable Deadtime Control
- Uncommitted Output Transistors Rated to 500 mA Source or Sink
- Output Control for Push-Pull or Single-Ended Operation
- Undervoltage Lockout

MAXIMUM RATINGS (Full operating ambient temperature range applies, unless otherwise noted.)

Rating	Symbol	TL494C	TL494I	Unit
Power Supply Voltage	V _{CC}	42		V
Collector Output Voltage	V _{C1} , V _{C2}	42		V
Collector Output Current (Each transistor) (Note 1.)	I _{C1} , I _{C2}	500		mA
Amplifier Input Voltage Range	V _{IR}	−0.3 to +42		V
Power Dissipation @ T _A ≤ 45°C	P _D	1000		mW
Thermal Resistance, Junction-to-Ambient	R _{θJA}	80		°C/W
Operating Junction Temperature	T _J	125		°C
Storage Temperature Range	T _{stg}	−55 to +125		°C
Operating Ambient Temperature Range TL494C TL494I	T _A	0 to +70 −40 to +85		°C
Derating Ambient Temperature	T _A	45		°C

1. Maximum thermal limits must be observed.

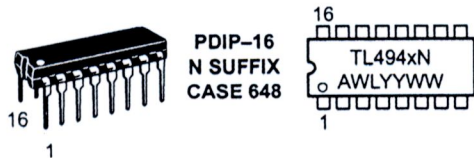
PIN CONNECTIONS



ON Semiconductor

http://onsemi.com

MARKING DIAGRAMS



x = C or I
A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week

ORDERING INFORMATION

Device	Package	Shipping
TL494CD	SO-16	48 Units/Rail
TL494CDR2	SO-16	2500 Tape & Reel
TL494CN	PDIP-16	500 Units/Rail
TL494IN	PDIP-16	500 Units/Rail

TL494

RECOMMENDED OPERATING CONDITIONS

Characteristics	Symbol	Min	Typ	Max	Unit
Power Supply Voltage	V_{CC}	7.0	15	40	V
Collector Output Voltage	V_{C1}, V_{C2}	–	30	40	V
Collector Output Current (Each transistor)	I_{C1}, I_{C2}	–	–	200	mA
Amplified Input Voltage	V_{in}	–0.3	–	$V_{CC} - 2.0$	V
Current Into Feedback Terminal	I_{fb}	–	–	0.3	mA
Reference Output Current	I_{ref}	–	–	10	mA
Timing Resistor	R_T	1.8	30	500	k Ω
Timing Capacitor	C_T	0.0047	0.001	10	μ F
Oscillator Frequency	f_{osc}	1.0	40	200	kHz

ELECTRICAL CHARACTERISTICS ($V_{CC} = 15$ V, $C_T = 0.01$ μ F, $R_T = 12$ k Ω , unless otherwise noted.)

For typical values $T_A = 25^\circ\text{C}$, for min/max values T_A is the operating ambient temperature range that applies, unless otherwise noted.

Characteristics	Symbol	Min	Typ	Max	Unit
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REFERENCE SECTION

Reference Voltage ($I_O = 1.0$ mA)	V_{ref}	4.75	5.0	5.25	V
Line Regulation ($V_{CC} = 7.0$ V to 40 V)	Reg_{line}	–	2.0	25	mV
Load Regulation ($I_O = 1.0$ mA to 10 mA)	Reg_{load}	–	3.0	15	mV
Short Circuit Output Current ($V_{ref} = 0$ V)	I_{SC}	15	35	75	mA

OUTPUT SECTION

Collector Off-State Current ($V_{CC} = 40$ V, $V_{CE} = 40$ V)	$I_{C(off)}$	–	2.0	100	μ A
Emitter Off-State Current $V_{CC} = 40$ V, $V_C = 40$ V, $V_E = 0$ V)	$I_{E(off)}$	–	–	–100	μ A
Collector–Emitter Saturation Voltage (Note 2.) Common–Emitter ($V_E = 0$ V, $I_C = 200$ mA) Emitter–Follower ($V_C = 15$ V, $I_E = -200$ mA)	$V_{sat(C)}$ $V_{sat(E)}$	– –	1.1 1.5	1.3 2.5	V
Output Control Pin Current Low State ($V_{OC} \leq 0.4$ V) High State ($V_{OC} = V_{ref}$)	I_{OCL} I_{OCH}	– –	10 0.2	– 3.5	μ A mA
Output Voltage Rise Time Common–Emitter (See Figure 12) Emitter–Follower (See Figure 13)	t_r	– –	100 100	200 200	ns
Output Voltage Fall Time Common–Emitter (See Figure 12) Emitter–Follower (See Figure 13)	t_f	– –	25 40	100 100	ns

2. Low duty cycle pulse techniques are used during test to maintain junction temperature as close to ambient temperature as possible.

TL494

ELECTRICAL CHARACTERISTICS ($V_{CC} = 15\text{ V}$, $C_T = 0.01\text{ }\mu\text{F}$, $R_T = 12\text{ k}\Omega$, unless otherwise noted.)

For typical values $T_A = 25^\circ\text{C}$, for min/max values T_A is the operating ambient temperature range that applies, unless otherwise noted.

Characteristics	Symbol	Min	Typ	Max	Unit
ERROR AMPLIFIER SECTION					
Input Offset Voltage (V_O (Pin 3) = 2.5 V)	V_{IO}	–	2.0	10	mV
Input Offset Current (V_O (Pin 3) = 2.5 V)	I_{IO}	–	5.0	250	nA
Input Bias Current (V_O (Pin 3) = 2.5 V)	I_{IB}	–	–0.1	–1.0	μA
Input Common Mode Voltage Range ($V_{CC} = 40\text{ V}$, $T_A = 25^\circ\text{C}$)	V_{ICR}	–0.3 to V_{CC} –2.0			V
Open Loop Voltage Gain ($\Delta V_O = 3.0\text{ V}$, $V_O = 0.5\text{ V}$ to 3.5 V , $R_L = 2.0\text{ k}\Omega$)	A_{VOL}	70	95	–	dB
Unity–Gain Crossover Frequency ($V_O = 0.5\text{ V}$ to 3.5 V , $R_L = 2.0\text{ k}\Omega$)	f_{C-}	–	350	–	kHz
Phase Margin at Unity–Gain ($V_O = 0.5\text{ V}$ to 3.5 V , $R_L = 2.0\text{ k}\Omega$)	ϕ_m	–	65	–	deg.
Common Mode Rejection Ratio ($V_{CC} = 40\text{ V}$)	CMRR	65	90	–	dB
Power Supply Rejection Ratio ($\Delta V_{CC} = 33\text{ V}$, $V_O = 2.5\text{ V}$, $R_L = 2.0\text{ k}\Omega$)	PSRR	–	100	–	dB
Output Sink Current (V_O (Pin 3) = 0.7 V)	I_{O-}	0.3	0.7	–	mA
Output Source Current (V_O (Pin 3) = 3.5 V)	I_{O+}	2.0	–4.0	–	mA

PWM COMPARATOR SECTION (Test Circuit Figure 11)

Input Threshold Voltage (Zero Duty Cycle)	V_{TH}	–	2.5	4.5	V
Input Sink Current ($V_{(Pin\ 3)} = 0.7\text{ V}$)	I_{L-}	0.3	0.7	–	mA

DEADTIME CONTROL SECTION (Test Circuit Figure 11)

Input Bias Current (Pin 4) ($V_{Pin\ 4} = 0\text{ V}$ to 5.25 V)	I_{IB} (DT)	–	–2.0	–10	μA
Maximum Duty Cycle, Each Output, Push–Pull Mode ($V_{Pin\ 4} = 0\text{ V}$, $C_T = 0.01\text{ }\mu\text{F}$, $R_T = 12\text{ k}\Omega$) ($V_{Pin\ 4} = 0\text{ V}$, $C_T = 0.001\text{ }\mu\text{F}$, $R_T = 30\text{ k}\Omega$)	DC_{max}	45 –	48 45	50 50	%
Input Threshold Voltage (Pin 4) (Zero Duty Cycle) (Maximum Duty Cycle)	V_{th}	– 0	2.8 –	3.3 –	V

OSCILLATOR SECTION

Frequency ($C_T = 0.001\text{ }\mu\text{F}$, $R_T = 30\text{ k}\Omega$)	f_{osc}	–	40	–	kHz
Standard Deviation of Frequency* ($C_T = 0.001\text{ }\mu\text{F}$, $R_T = 30\text{ k}\Omega$)	σ_{osc}	–	3.0	–	%
Frequency Change with Voltage ($V_{CC} = 7.0\text{ V}$ to 40 V , $T_A = 25^\circ\text{C}$)	Δf_{osc} (ΔV)	–	0.1	–	%
Frequency Change with Temperature ($\Delta T_A = T_{low}$ to T_{high}) ($C_T = 0.01\text{ }\mu\text{F}$, $R_T = 12\text{ k}\Omega$)	Δf_{osc} (ΔT)	–	–	12	%

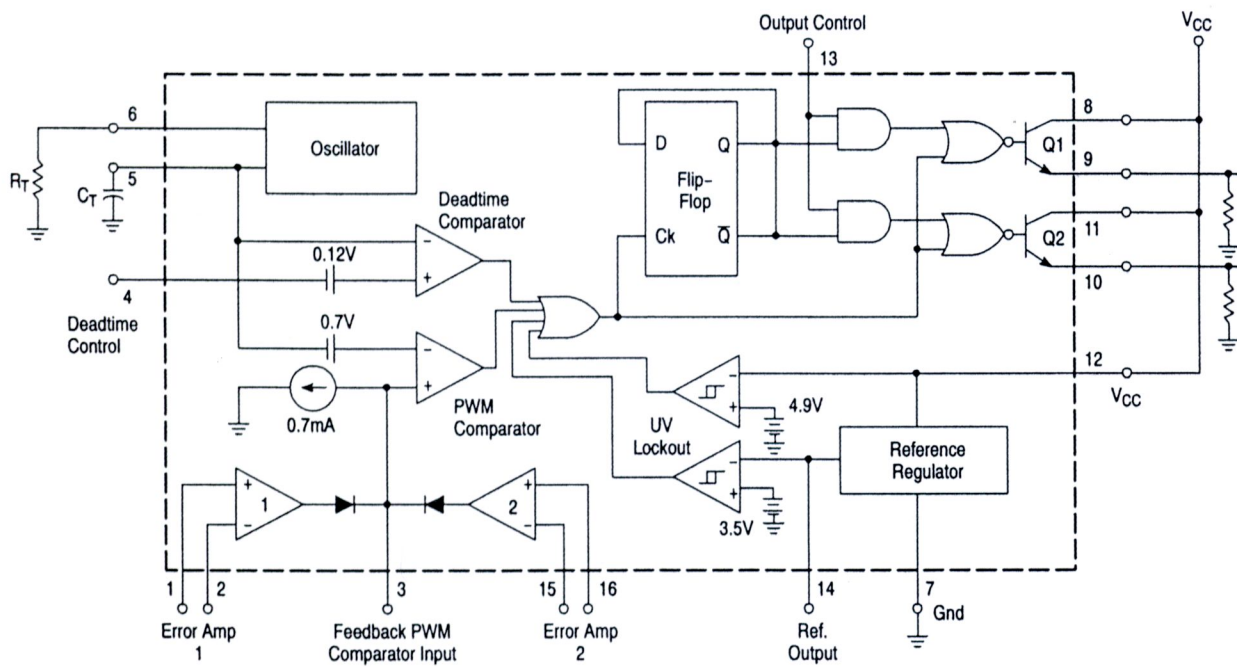
UNDERVOLTAGE LOCKOUT SECTION

Turn–On Threshold (V_{CC} increasing, $I_{ref} = 1.0\text{ mA}$)	V_{th}	5.5	6.43	7.0	V
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TOTAL DEVICE

Standby Supply Current (Pin 6 at V_{ref} , All other inputs and outputs open) ($V_{CC} = 15\text{ V}$) ($V_{CC} = 40\text{ V}$)	I_{CC}	– –	5.5 7.0	10 15	mA
Average Supply Current ($C_T = 0.01\text{ }\mu\text{F}$, $R_T = 12\text{ k}\Omega$, $V_{(Pin\ 4)} = 2.0\text{ V}$) ($V_{CC} = 15\text{ V}$) (See Figure 12)		–	7.0	–	mA

* Standard deviation is a measure of the statistical distribution about the mean as derived from the formula, $\sigma = \sqrt{\frac{\sum_{n=1}^N (X_n - \bar{X})^2}{N - 1}}$

TL494

This device contains 46 active transistors.

Figure 1. Representative Block Diagram

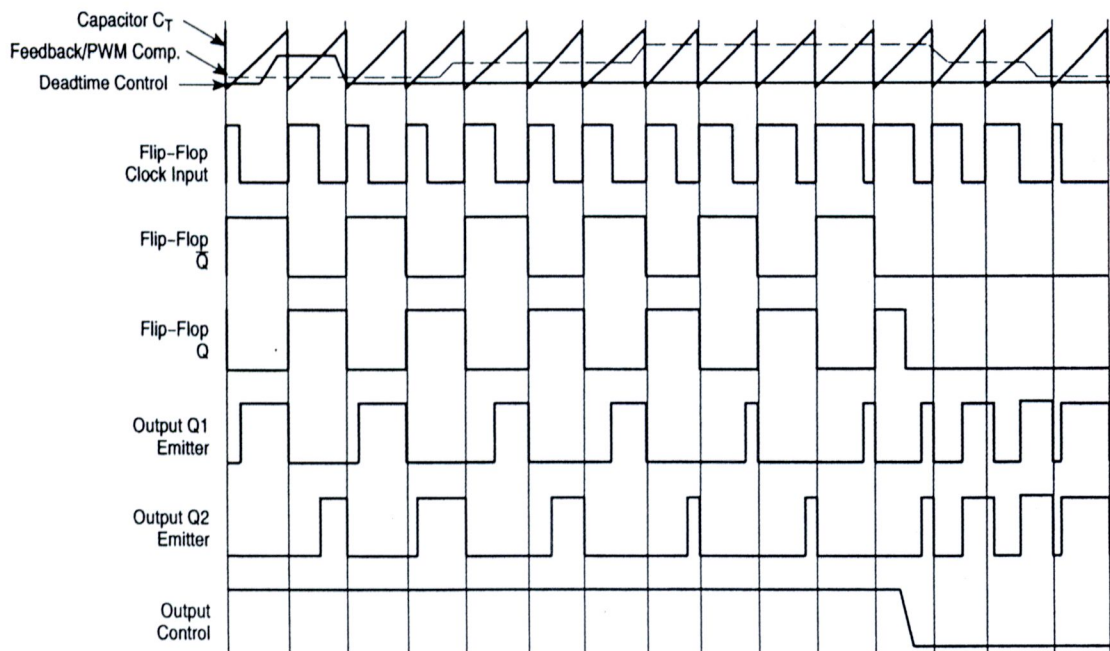


Figure 2. Timing Diagram

APPLICATIONS INFORMATION

Description

The TL494 is a fixed-frequency pulse width modulation control circuit, incorporating the primary building blocks required for the control of a switching power supply. (See Figure 1.) An internal-linear sawtooth oscillator is frequency-programmable by two external components, R_T and C_T . The approximate oscillator frequency is determined by:

$$f_{osc} \approx \frac{1.1}{R_T \cdot C_T}$$

For more information refer to Figure 3.

Output pulse width modulation is accomplished by comparison of the positive sawtooth waveform across capacitor C_T to either of two control signals. The NOR gates, which drive output transistors Q1 and Q2, are enabled only when the flip-flop clock-input line is in its low state. This happens only during that portion of time when the sawtooth voltage is greater than the control signals. Therefore, an increase in control-signal amplitude causes a corresponding linear decrease of output pulse width. (Refer to the Timing Diagram shown in Figure 2.)

The control signals are external inputs that can be fed into the deadtime control, the error amplifier inputs, or the feedback input. The deadtime control comparator has an effective 120 mV input offset which limits the minimum output deadtime to approximately the first 4% of the sawtooth-cycle time. This would result in a maximum duty cycle on a given output of 96% with the output control grounded, and 48% with it connected to the reference line. Additional deadtime may be imposed on the output by setting the deadtime-control input to a fixed voltage, ranging between 0 V to 3.3 V.

Functional Table

Input/Output Controls	Output Function	$\frac{f_{out}}{f_{osc}} =$
Grounded	Single-ended PWM @ Q1 and Q2	1.0
@ V_{ref}	Push-pull Operation	0.5

The pulse width modulator comparator provides a means for the error amplifiers to adjust the output pulse width from the maximum percent on-time, established by the deadtime control input, down to zero, as the voltage at the feedback pin varies from 0.5 V to 3.5 V. Both error amplifiers have a

common mode input range from -0.3 V to ($V_{CC} - 2V$), and may be used to sense power-supply output voltage and current. The error-amplifier outputs are active high and are ORed together at the noninverting input of the pulse-width modulator comparator. With this configuration, the amplifier that demands minimum output on time, dominates control of the loop.

When capacitor C_T is discharged, a positive pulse is generated on the output of the deadtime comparator, which clocks the pulse-steering flip-flop and inhibits the output transistors, Q1 and Q2. With the output-control connected to the reference line, the pulse-steering flip-flop directs the modulated pulses to each of the two output transistors alternately for push-pull operation. The output frequency is equal to half that of the oscillator. Output drive can also be taken from Q1 or Q2, when single-ended operation with a maximum on-time of less than 50% is required. This is desirable when the output transformer has a ringback winding with a catch diode used for snubbing. When higher output-drive currents are required for single-ended operation, Q1 and Q2 may be connected in parallel, and the output-mode pin must be tied to ground to disable the flip-flop. The output frequency will now be equal to that of the oscillator.

The TL494 has an internal 5.0 V reference capable of sourcing up to 10 mA of load current for external bias circuits. The reference has an internal accuracy of $\pm 5.0\%$ with a typical thermal drift of less than 50 mV over an operating temperature range of 0° to 70°C.

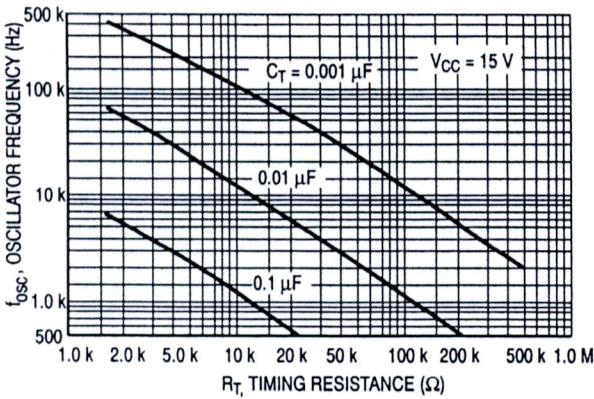


Figure 3. Oscillator Frequency versus Timing Resistance



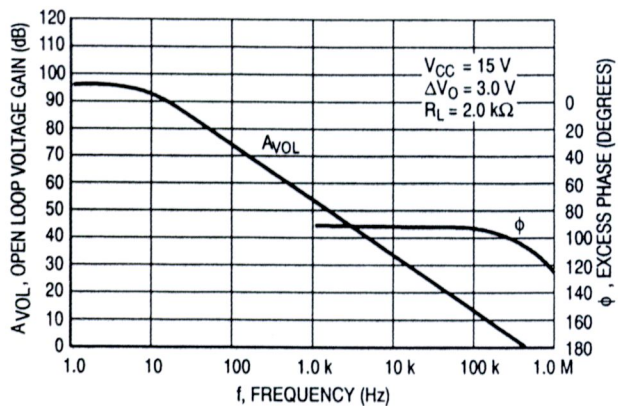


Figure 4. Open Loop Voltage Gain and Phase versus Frequency

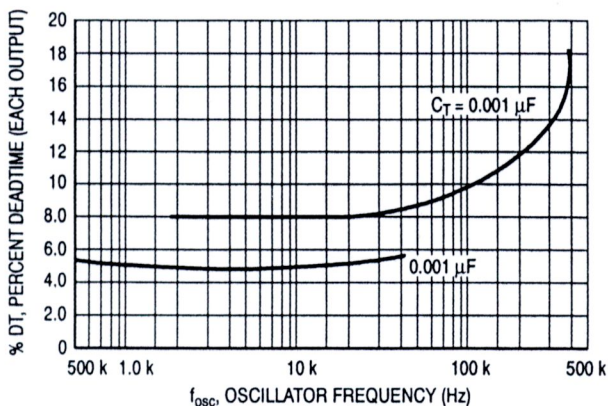


Figure 5. Percent Deadtime versus Oscillator Frequency

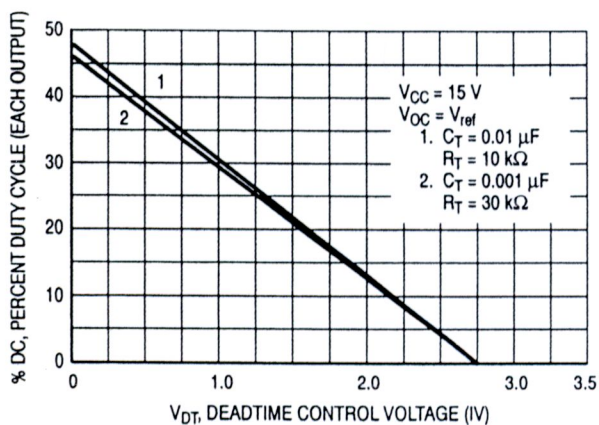


Figure 6. Percent Duty Cycle versus Deadtime Control Voltage

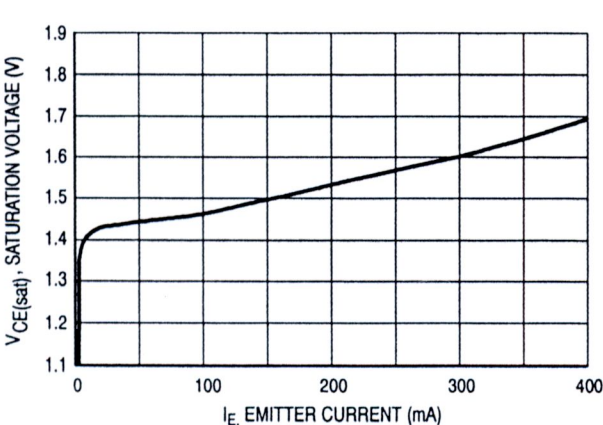


Figure 7. Emitter-Follower Configuration Output Saturation Voltage versus Emitter Current

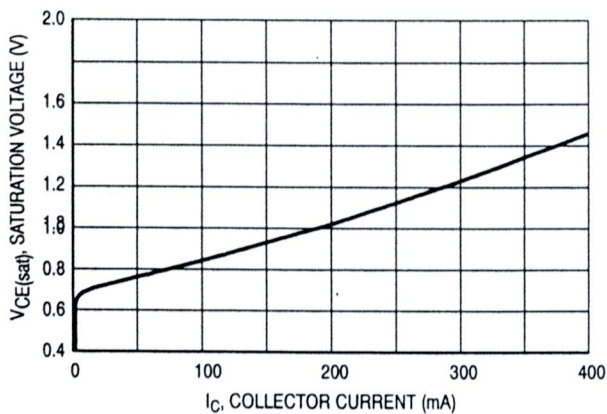


Figure 8. Common-Emitter Configuration Output Saturation Voltage versus Collector Current

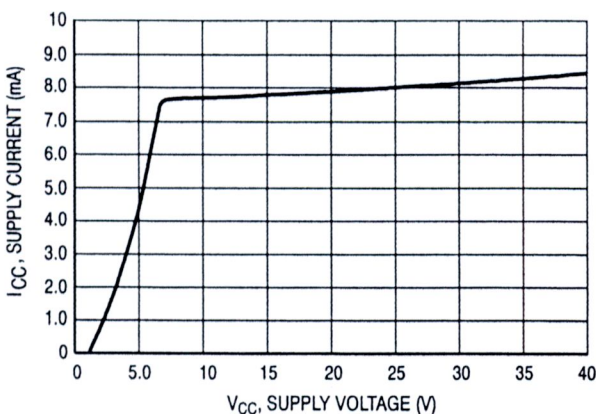


Figure 9. Standby Supply Current versus Supply Voltage

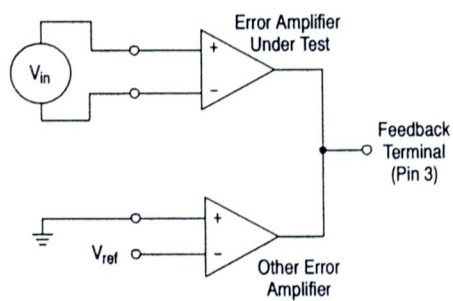


Figure 10. Error-Amplifier Characteristics

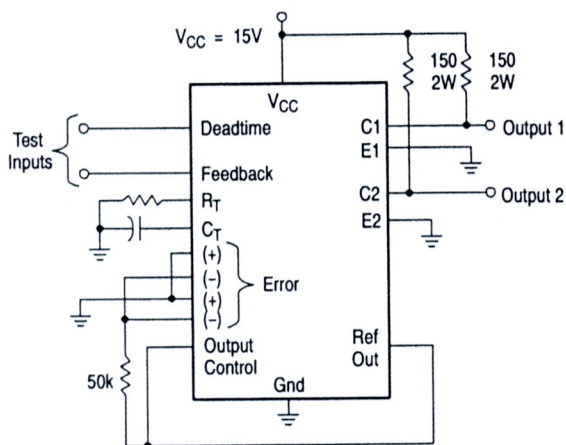


Figure 11. Deadtime and Feedback Control Circuit

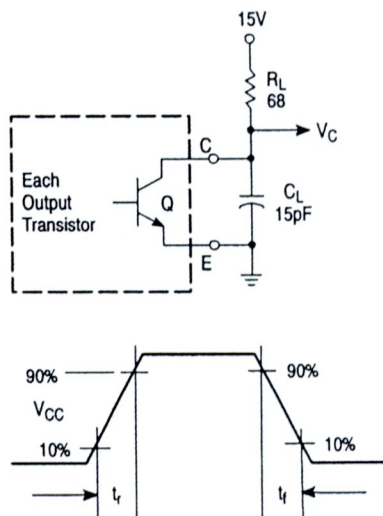


Figure 12. Common-Emitter Configuration Test Circuit and Waveform

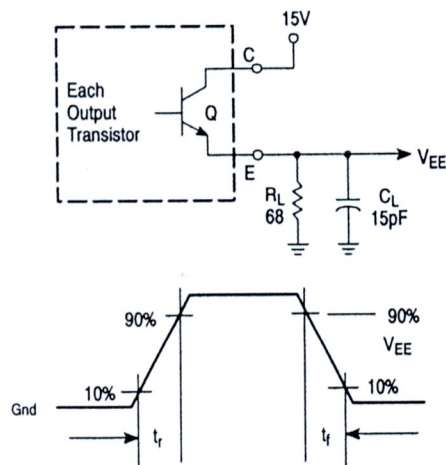


Figure 13. Emitter-Follower Configuration Test Circuit and Waveform

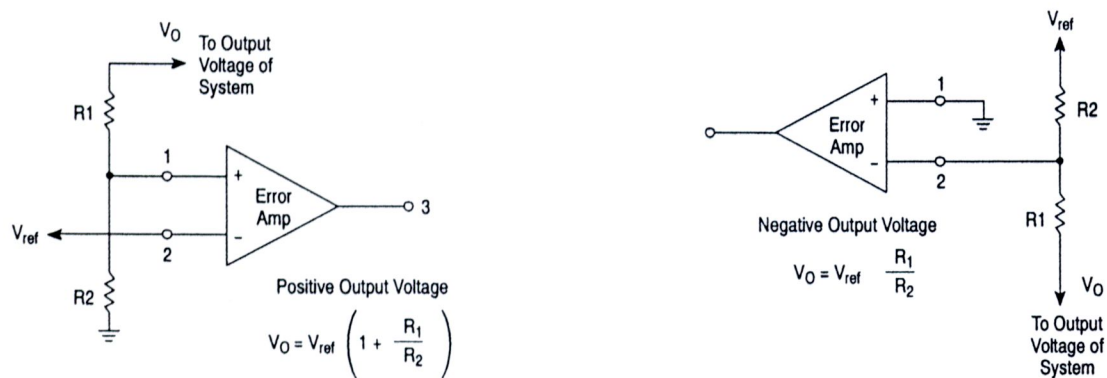


Figure 14. Error-Amplifier Sensing Techniques

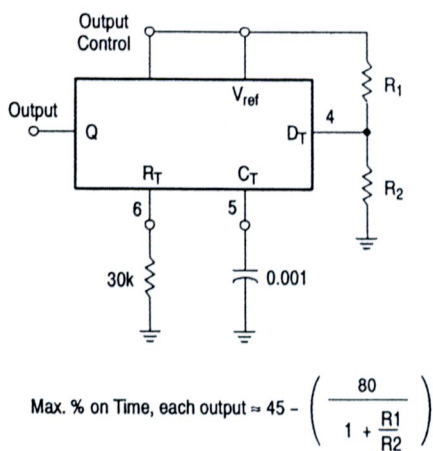


Figure 15. Deadtime Control Circuit

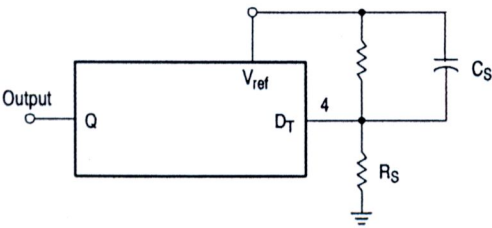


Figure 16. Soft-Start Circuit

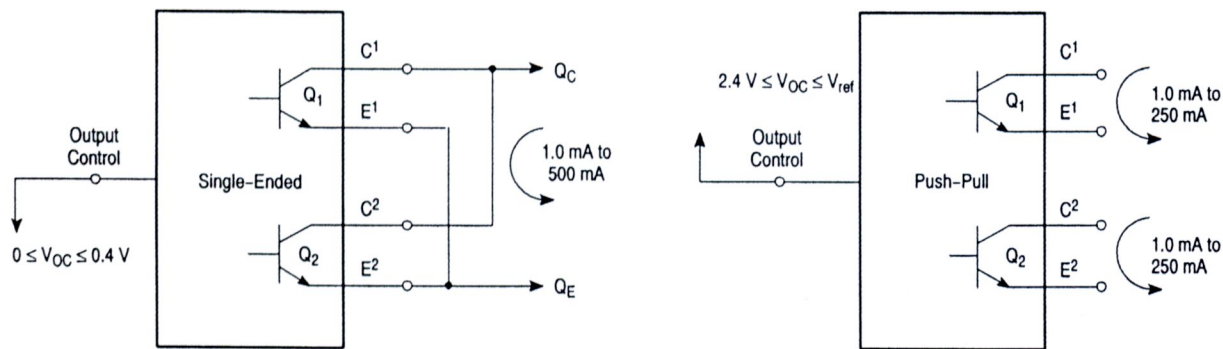


Figure 17. Output Connections for Single-Ended and Push-Pull Configurations

TL494

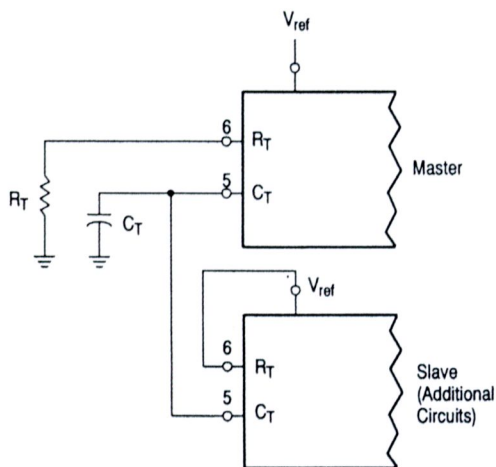


Figure 18. Slaving Two or More Control Circuits

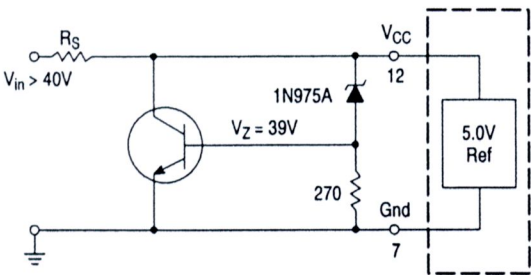


Figure 19. Operation with $V_{in} > 40\text{ V}$ Using External Zener

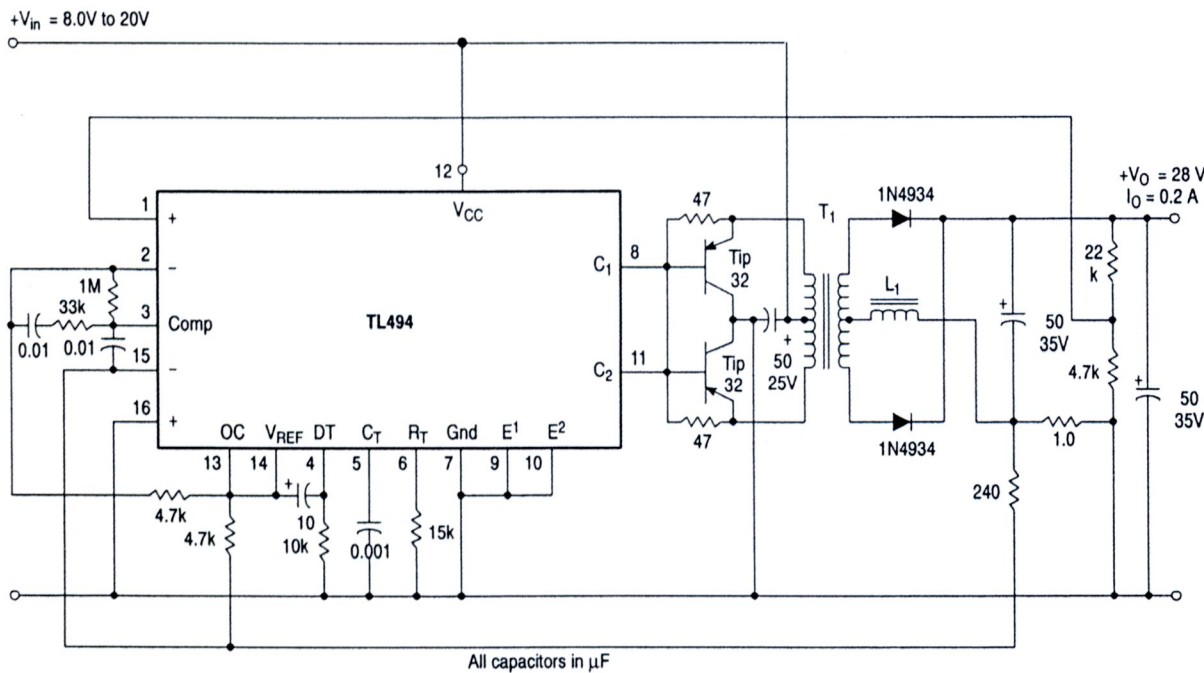


Figure 20. Pulse Width Modulated Push-Pull Converter

Test	Conditions	Results
Line Regulation	$V_{in} = 10\text{ V to } 40\text{ V}$	14 mV 0.28%
Load Regulation	$V_{in} = 28\text{ V, } I_O = 1.0\text{ mA to } 1.0\text{ A}$	3.0 mV 0.06%
Output Ripple	$V_{in} = 28\text{ V, } I_O = 1.0\text{ A}$	65 mV pp P.A.R.D.
Short Circuit Current	$V_{in} = 28\text{ V, } R_L = 0.1\text{ }\Omega$	1.6 A
Efficiency	$V_{in} = 28\text{ V, } I_O = 1.0\text{ A}$	71%

L1 - 3.5 mH @ 0.3 A
T1 - Primary: 20T C.T. #28 AWG
Secondary: 120T C.T. #36 AWG
Core: Ferroxcube 1408P-L00-3CB

TL494

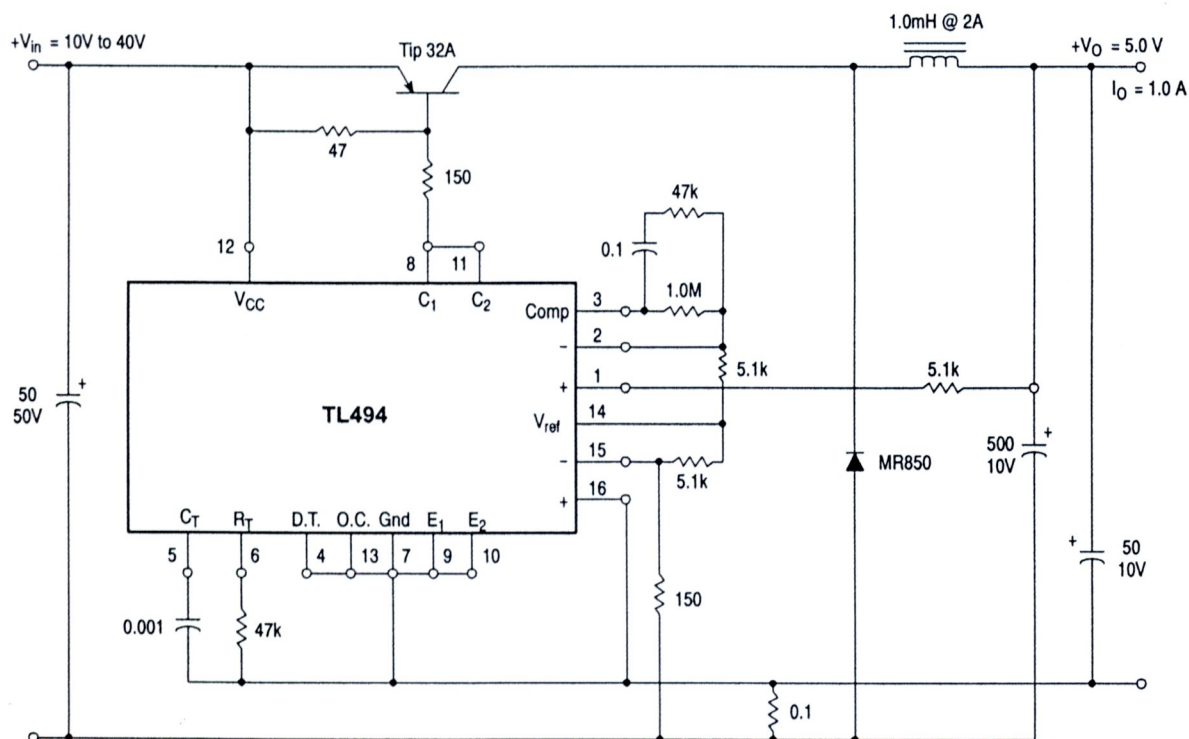


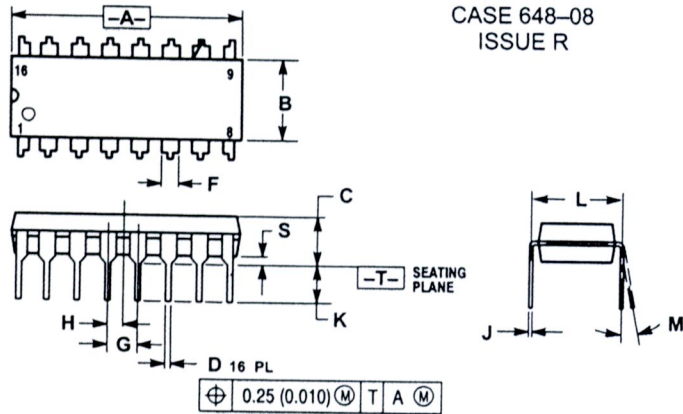
Figure 21. Pulse Width Modulated Step-Down Converter

Test	Conditions	Results
Line Regulation	$V_{in} = 8.0 \text{ V to } 40 \text{ V}$	3.0 mV 0.01%
Load Regulation	$V_{in} = 12.6 \text{ V}, I_O = 0.2 \text{ mA to } 200 \text{ mA}$	5.0 mV 0.02%
Output Ripple	$V_{in} = 12.6 \text{ V}, I_O = 200 \text{ mA}$	40 mV pp P.A.R.D.
Short Circuit Current	$V_{in} = 12.6 \text{ V}, R_L = 0.1 \Omega$	250 mA
Efficiency	$V_{in} = 12.6 \text{ V}, I_O = 200 \text{ mA}$	72%

TL494

PACKAGE DIMENSIONS

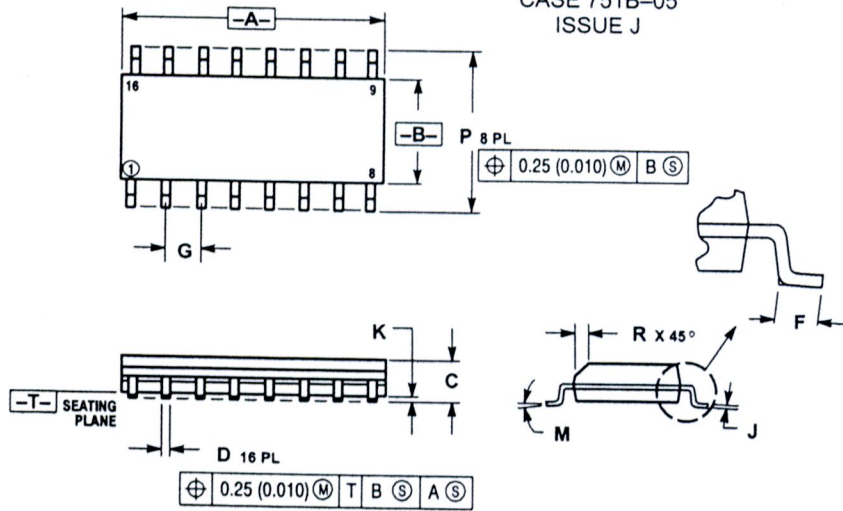
PDIP-16
N SUFFIX
CASE 648-08
ISSUE R



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC	2.54 BSC		
H	0.050 BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

SO-16
D SUFFIX
CASE 751B-05
ISSUE J



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC	0.050 BSC		
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

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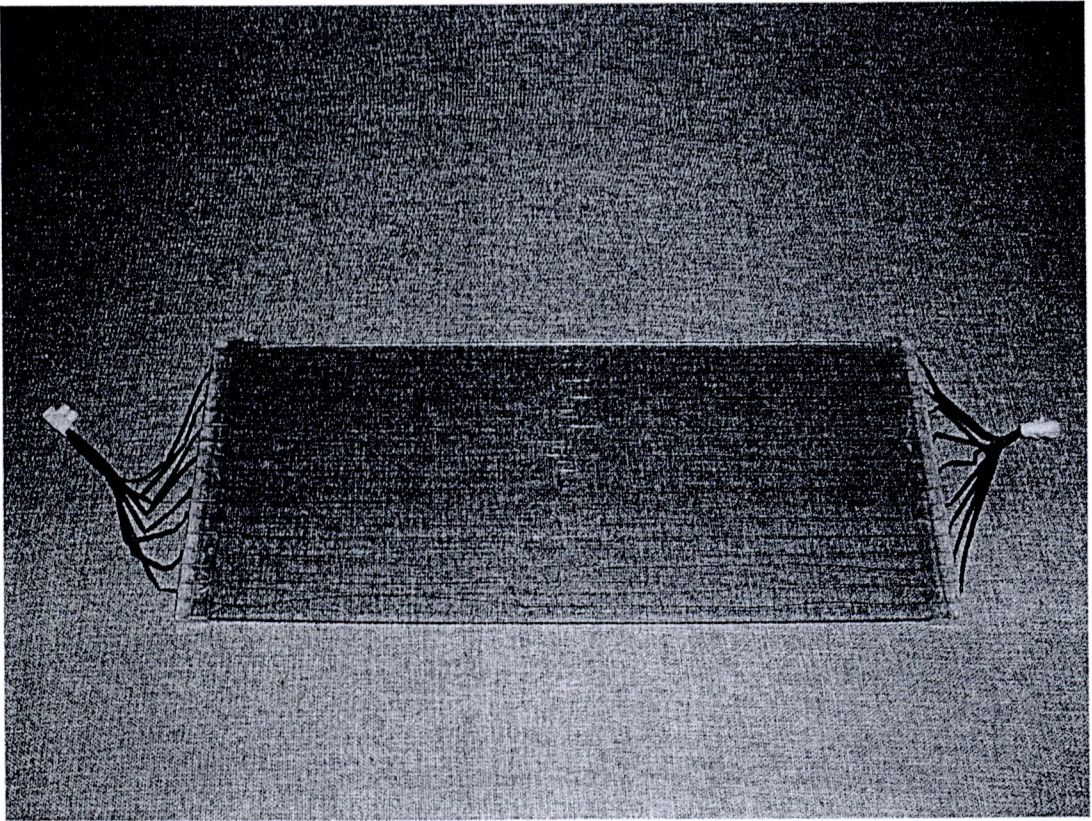
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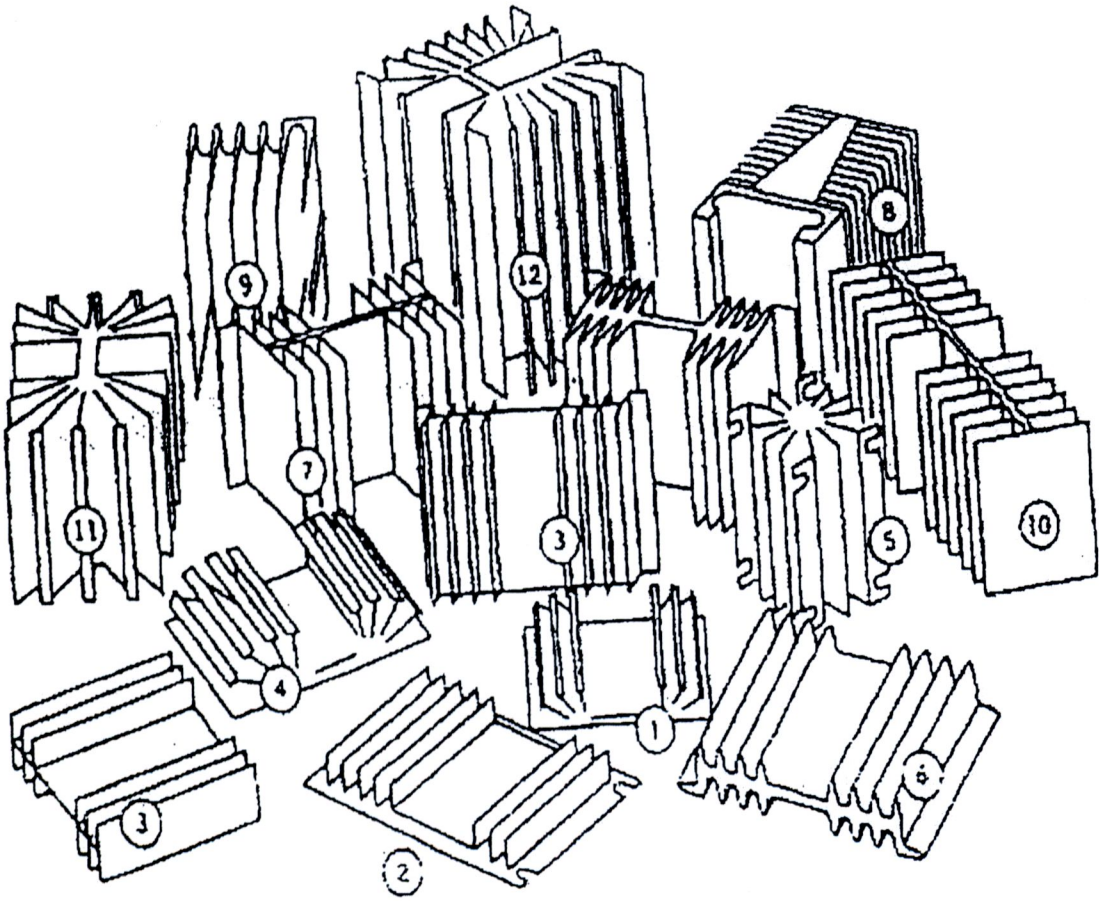
เส้นลวดตัวนำที่วางบนแผ่นกระจกสำหรับสร้างสนามไฟฟ้า
เพื่อสังเกตปฏิกิริยาของผึ้ง
(โหลดของแหล่งจ่ายไฟฟ้ากระแสสลับแรงสูง)



ภาคผนวก จ

ขนาดแผ่นระบายความร้อนของเพาเวอร์มอสเฟต





Heat Sink No.	1	2	3	4	5	6	7	8	9	10	11	12
$R_{\theta_{sa}} (^{\circ}\text{C}/\text{W})$	3.2	2.3	2.2	-	2.1	1.7	1.3	1.3	1.25	1.2	0.8	0.65
Vol.(cm ³)	76	99	181	-	198	298	435	675	608	634	695	1311

ภาคผนวก จ
ด้าต้าซี้ตไดโอด เบอร์ MUR840

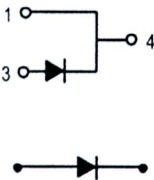
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... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 25, 50 and 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V_O @ 1/8"
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U820, U840, U860



MUR820
MUR840
MUR860

Motorola Preferred Devices

ULTRAFAST
RECTIFIERS
8 AMPERES
200-400-600 VOLTS

CASE 221B-03
TO-220AC

MAXIMUM RATINGS

Rating	Symbol	MUR			Unit
		820	840	860	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	400	600	Volts
Average Rectified Forward Current Total Device, (Rated V_R), $T_C = 150^{\circ}C$	$I_{F(AV)}$	8.0			Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 150^{\circ}C$	I_{FM}	16			Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	100			Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175			°C

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	2.0	°C/W
--	-----------------	-----	-----	------

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($I_F = 8.0$ Amps, $T_C = 150^{\circ}C$) ($I_F = 8.0$ Amps, $T_C = 25^{\circ}C$)	V_F	0.895 0.975	1.00 1.30	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 150^{\circ}C$) (Rated dc Voltage, $T_J = 25^{\circ}C$)	i_R	250 5.0	500 10		μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amps/μs) ($I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	t_{rr}	35 25	60 50		ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

SWITCHMODE is a trademark of Motorola, Inc.

Preferred devices are Motorola recommended choices for future use and best overall value.



MUR820

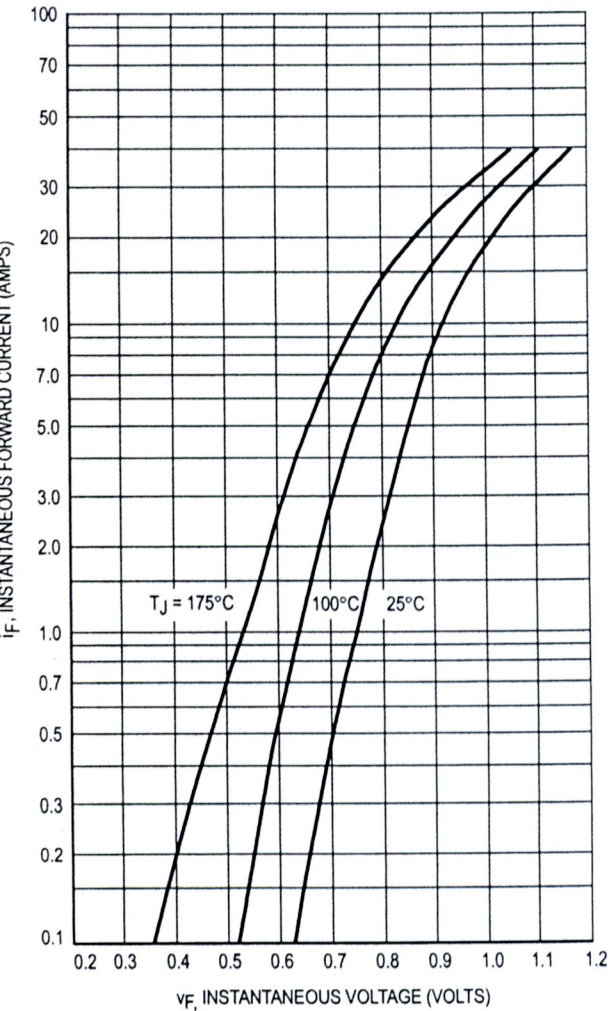


Figure 1. Typical Forward Voltage

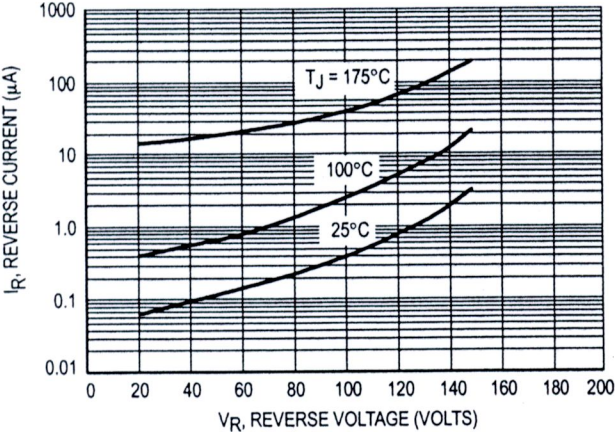


Figure 2. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

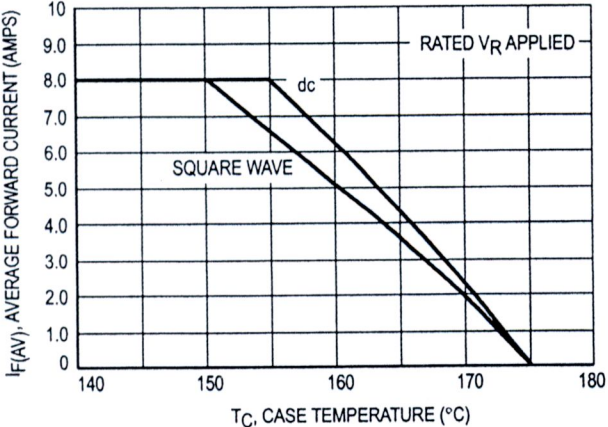


Figure 3. Current Derating, Case

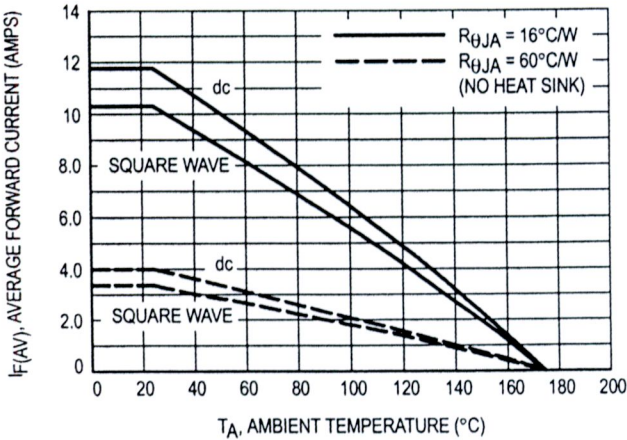


Figure 4. Current Derating, Ambient

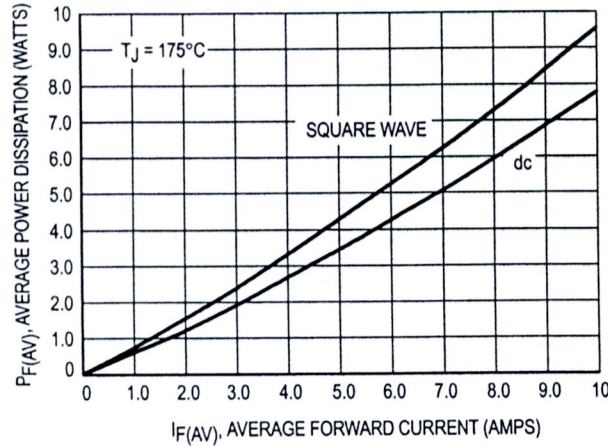


Figure 5. Power Dissipation

MUR840

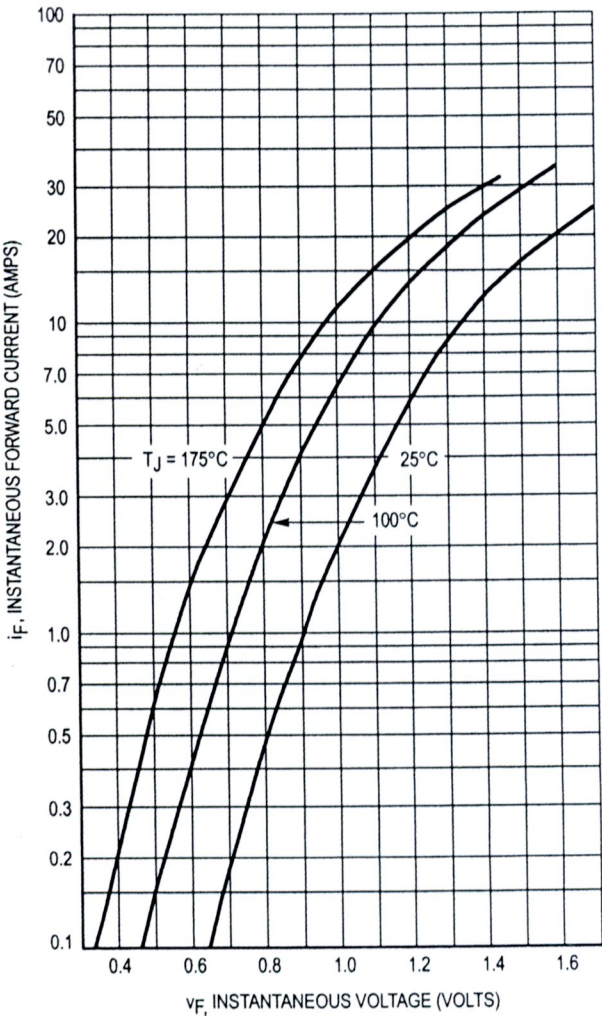


Figure 6. Typical Forward Voltage

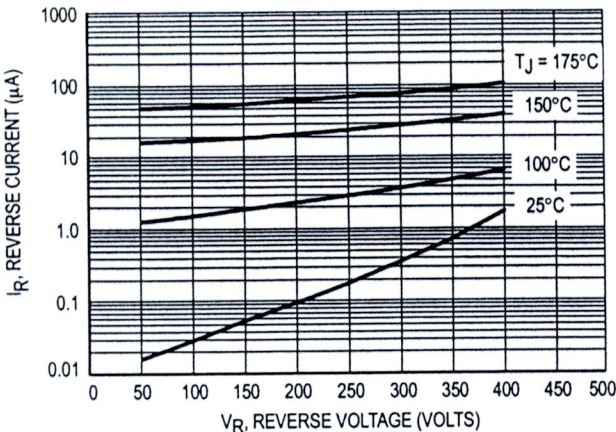


Figure 7. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

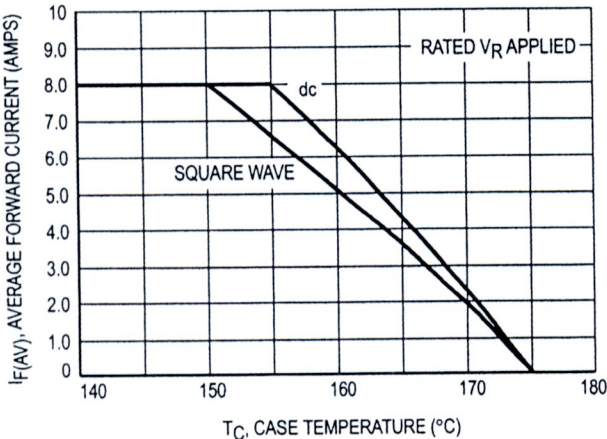


Figure 8. Current Derating, Case

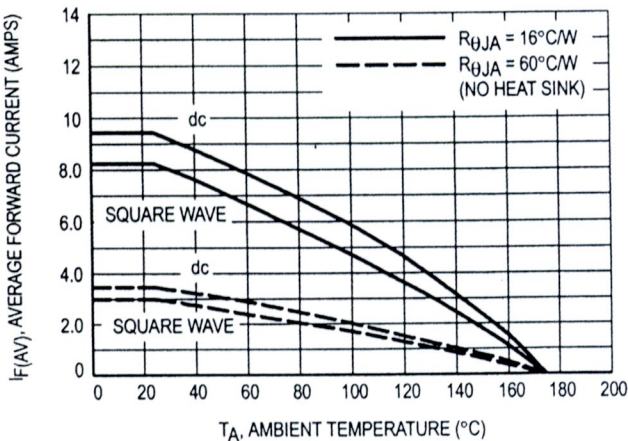


Figure 9. Current Derating, Ambient

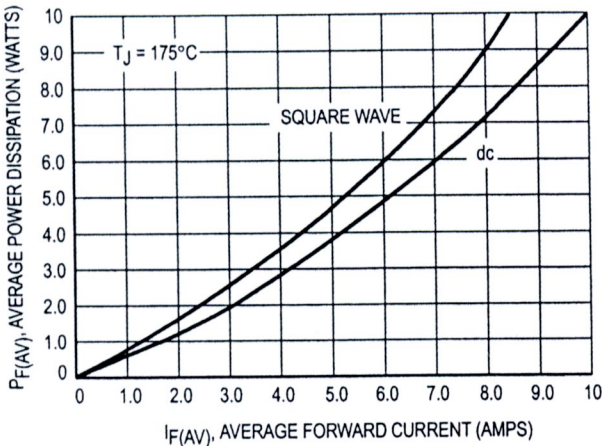


Figure 10. Power Dissipation

MUR860

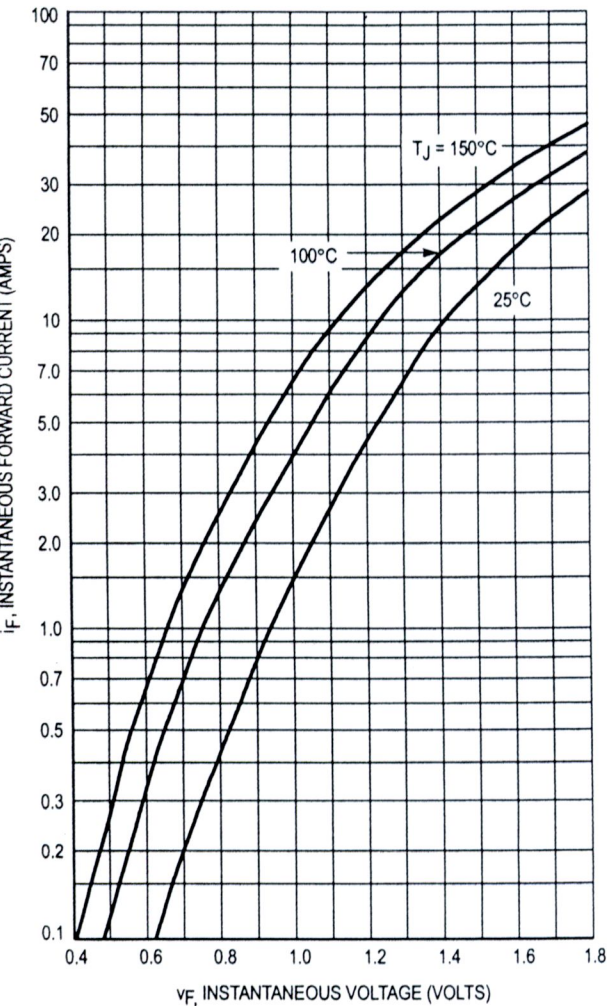


Figure 11. Typical Forward Voltage

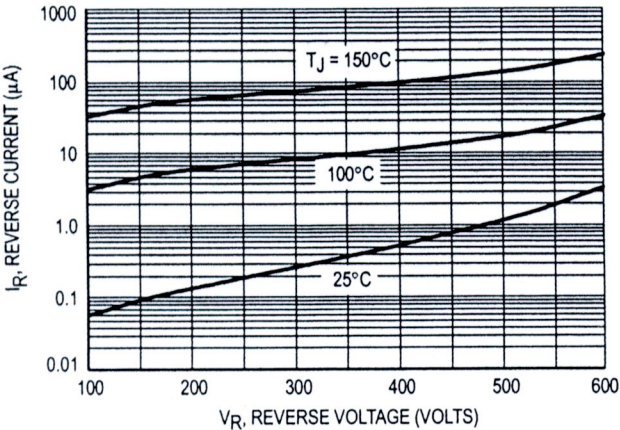


Figure 12. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

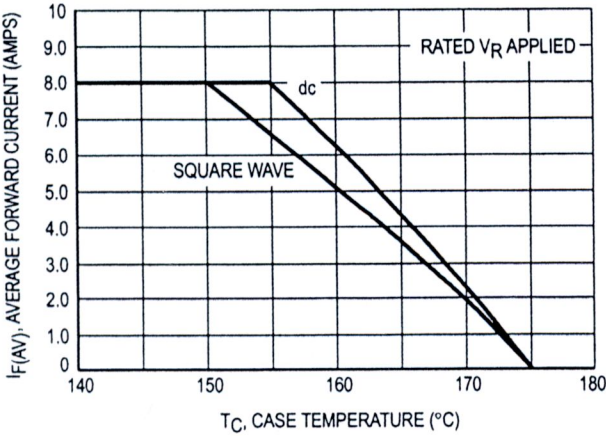


Figure 13. Current Derating, Case

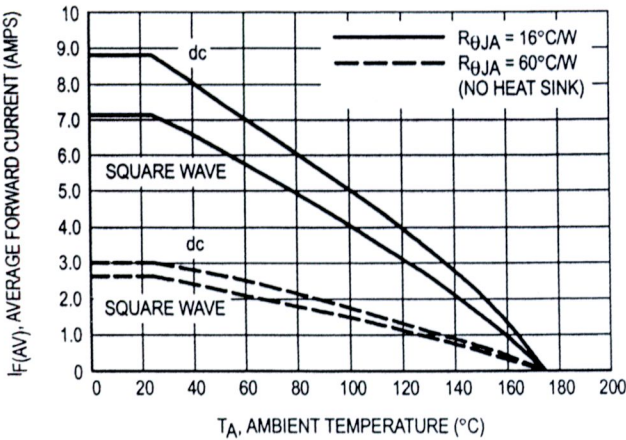


Figure 14. Current Derating, Ambient

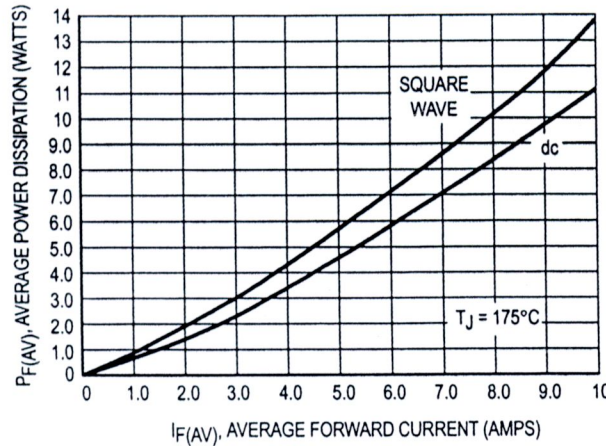


Figure 15. Power Dissipation

MUR820, MUR840, MUR860

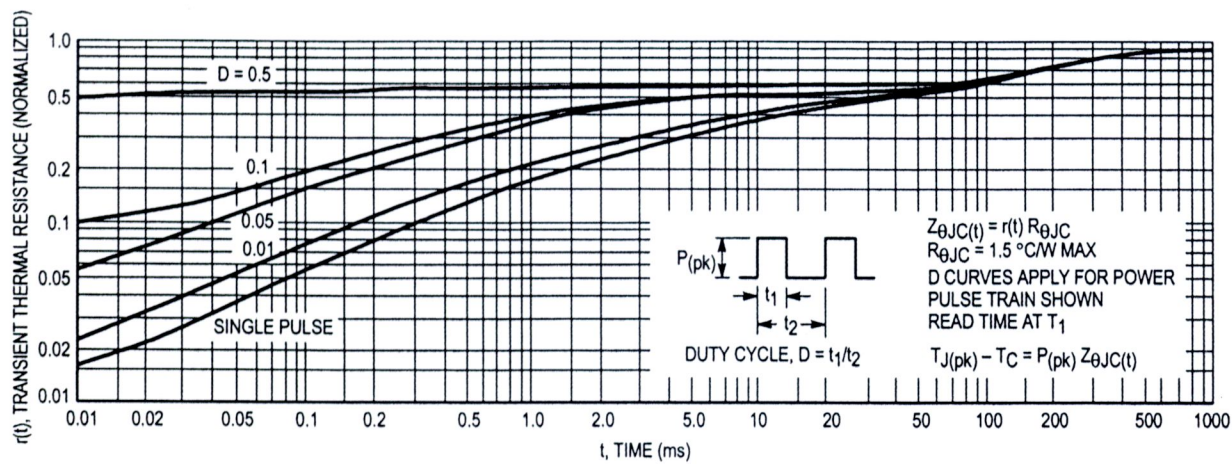


Figure 16. Thermal Response

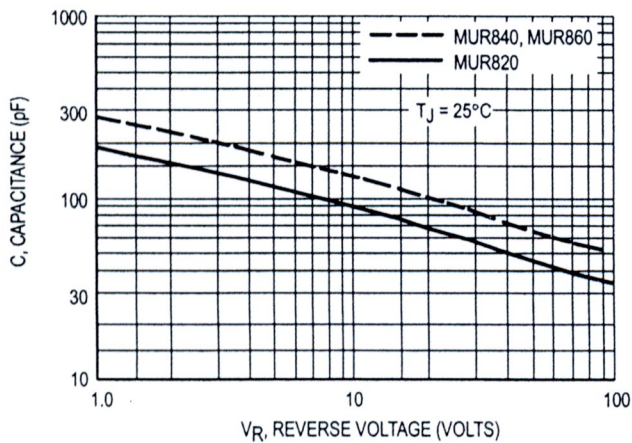
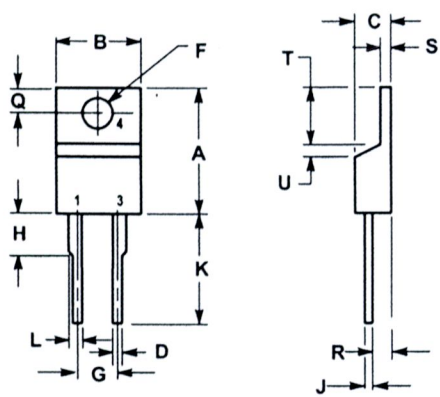


Figure 17. Typical Capacitance


PACKAGE DIMENSIONS



- NOTES:
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.595	0.620	15.11	15.75
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.82
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.190	0.210	4.83	5.33
H	0.110	0.130	2.79	3.30
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.14	1.39
T	0.235	0.255	5.97	6.48
U	0.000	0.050	0.000	1.27

CASE 221B-03
(TO-220AC)
ISSUE B

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